



Tool-Life Improvement by Deep-Cryogenic Treatment

Mr. Kaweerat Worasaen

Ph.D. student in Materials and Production Engineering

Advisor Asst. Prof. Dr. Karuna Tuchinda

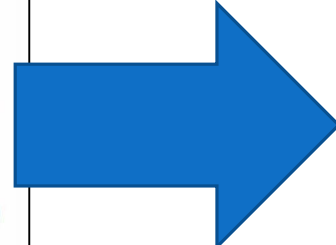
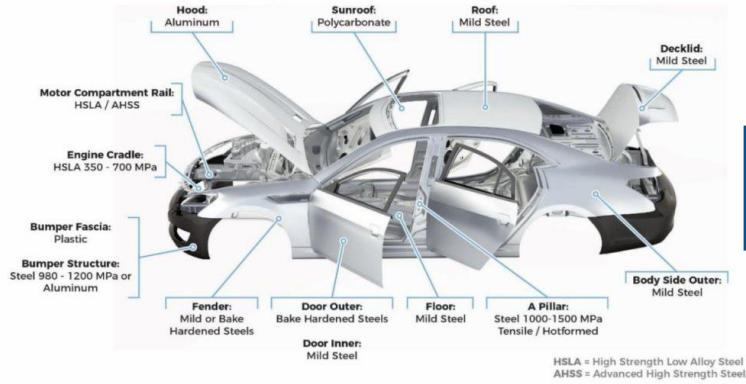
Co-Advisor Assoc. Prof. Dr. Piyada Suwanpinij

The Sirindhorn international Thai-German Graduate School of Engineering (TGGGS)

King Mongkut's University of Technology North Bangkok, Bangkok

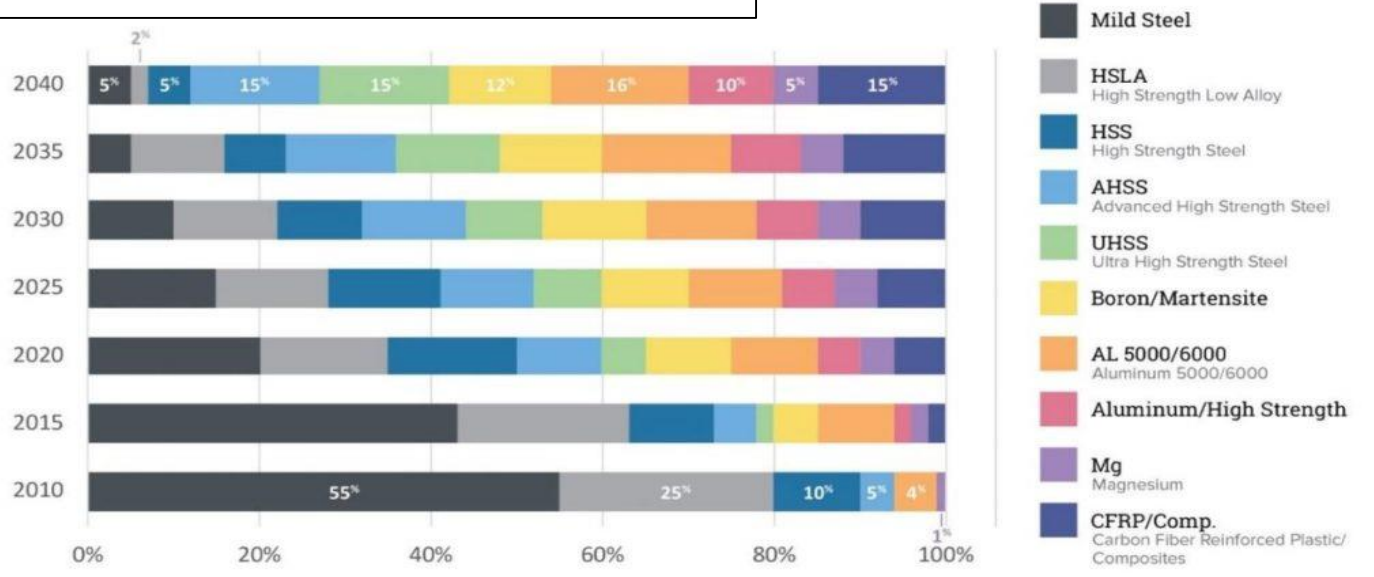
Introduction

Figure 7: Materials Used Most Commonly for Major Vehicle Structure Components in the Current Fleet



Increase automotive component efficiency

Reduce the weight/volume ratio



Picture Source: [CAR Research – Automotive Technology Roadmaps \(2017\)](#)

Longer tool life required !!



Chemical compositions (wt%)

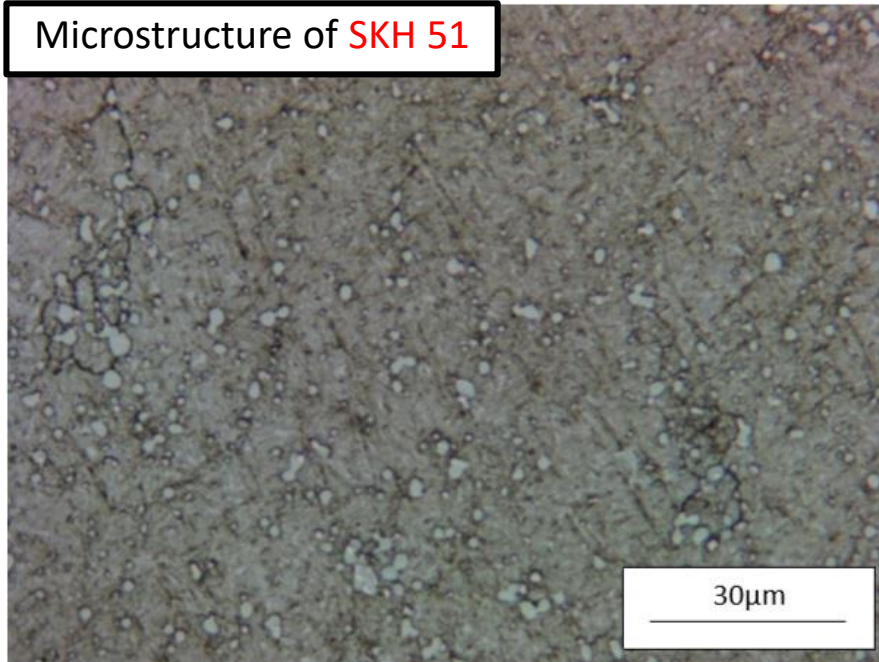
	C	Si	Mn	Cr	Mo	Ni	V	Fe
SKH51 (AISI M2)	0.94	0.31	0.29	3.78	4.67	0.26	1.75	79.9
YXR3	0.62	1.36	0.41	4.15	2.55	0.06	1.69	88.7

Microstructure of HSS

Chemical compositions of SKH51 (%wt.)

C	Si	Mn	Cr	W	Mo	V	Co
0.9	0.3	0.4	4.2	6.5	5.0	2.0	-

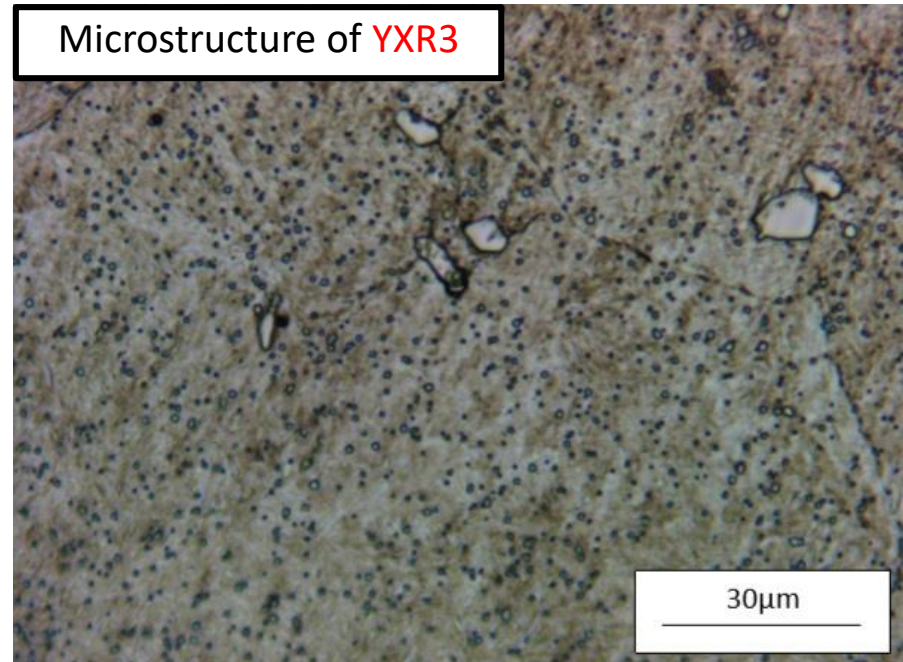
Microstructure of SKH 51



Chemical compositions of YXR3 (%wt.)

C	Si	Mn	Cr	W	Mo	V	Co
0.6	1.5	0.4	4.3	-	2.9	1.8	-

Microstructure of YXR3



- The amount of carbide in YXR3 is higher than SKH51
- The smaller carbides (dia.1.38 um) are randomly distributed along YXR3 compare to SKH51(dia. 2.19 um)

Wear of Tool Steels

Archard's equation

$$\dot{w} = k_0 \frac{P}{H}$$



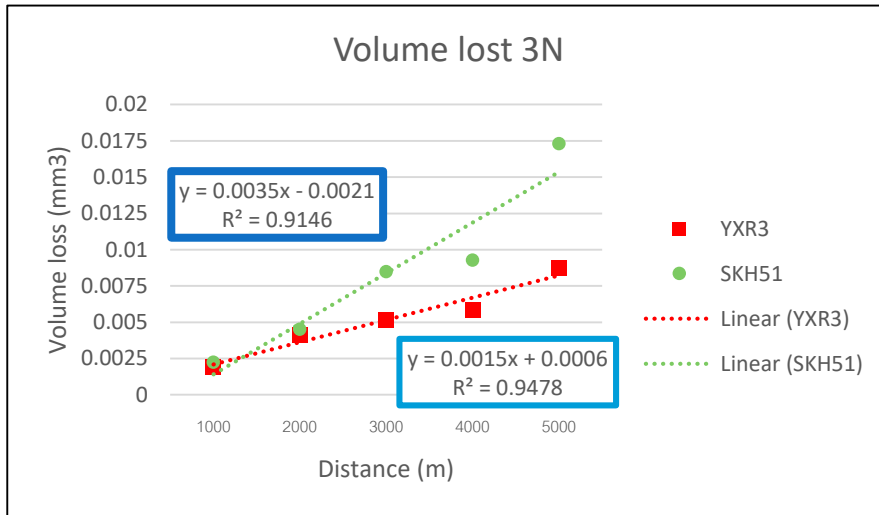
Modification of Archard's equation

$$\dot{w} = k \frac{P}{H} = k_0 \frac{\varepsilon_p \cdot P}{\varepsilon_c \cdot H} = k_0 \frac{\alpha P^{\frac{1}{2}} m^2 E \sigma_y P}{\beta H^{\frac{1}{2}} K_{IC}^2 H}$$

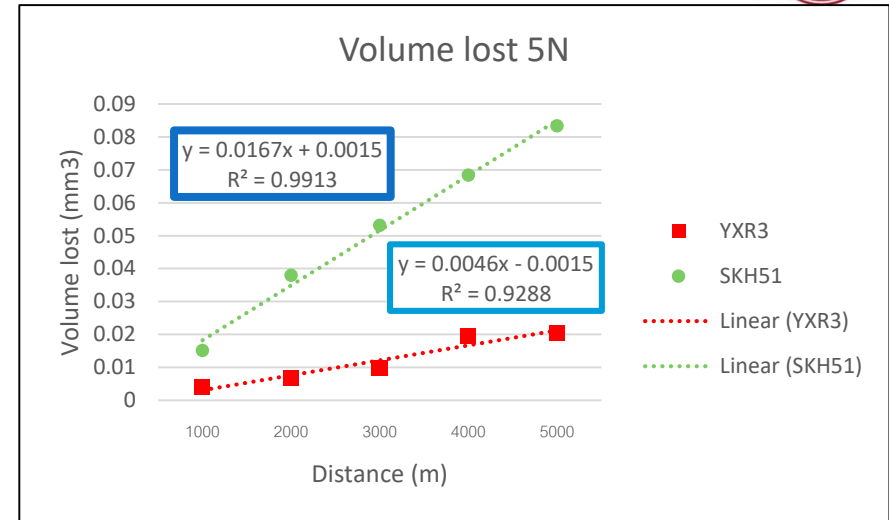
The **wear coefficient** k_0 , is defined as the probability that decohesion of a certain volume of matter occurs at a given area

This can be confirmed that **wear rate** of materials is controlled not only **Hardness** but **Toughness**

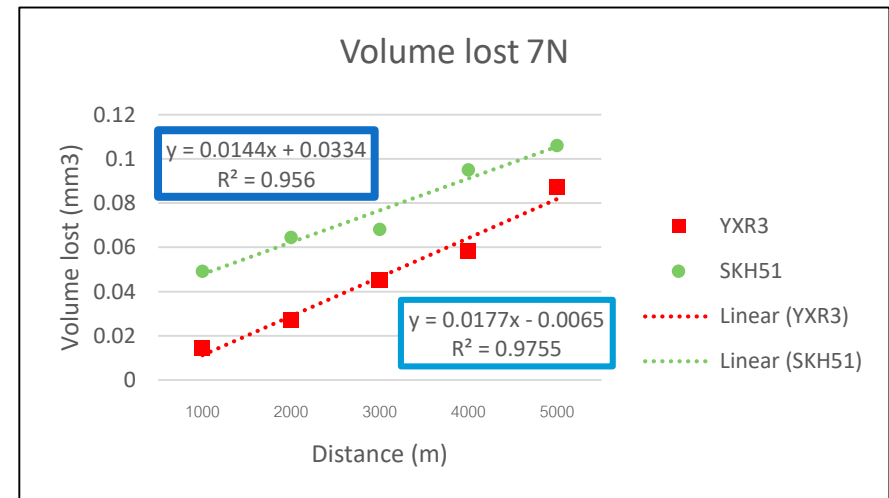
Wear testing Results



Wear volume loss of high-speed steel in 3N load



Wear volume loss of high-speed steel in 5N load

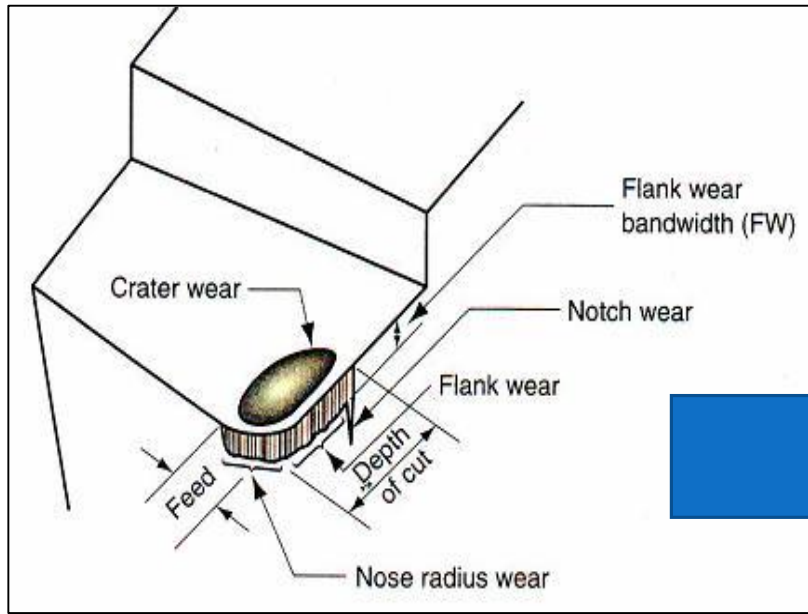


Wear volume loss of high-speed steel in 7N load

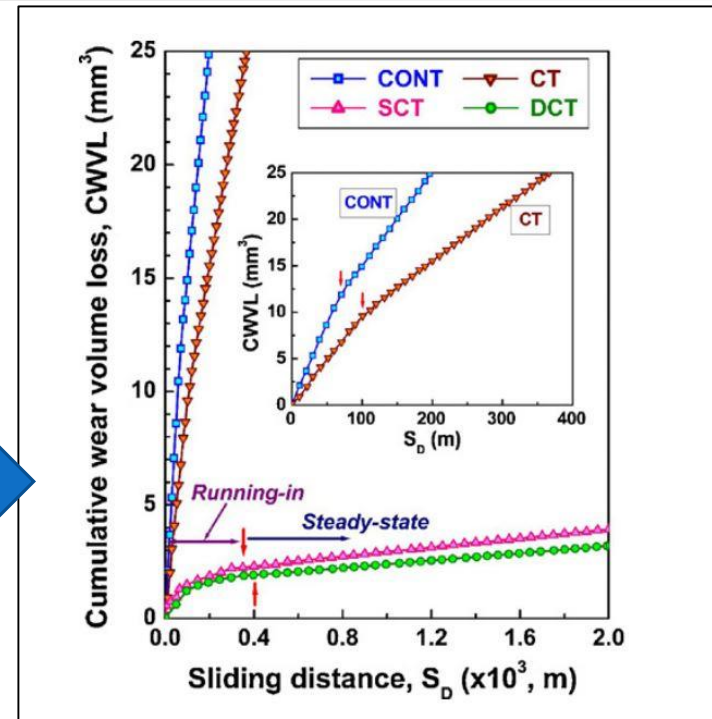
Testing Parameters

Load	3,5,7 N
Speed (Motor speed)	500 rpm
Sliding distance	5000 m
Ball Diameter	6 mm
Ball Material	WC-Co

Tool Life Improvement by DCT



Wear of cutting tools [1]

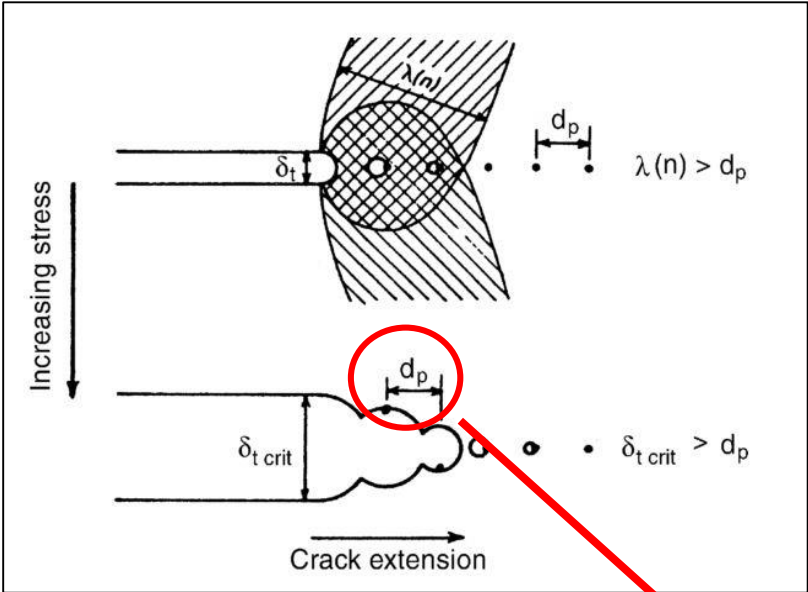


Plot of cumulative wear volume loss (CWVL) versus sliding distance (SD) for differently treated specimens tested at sliding velocity of 1.25ms⁻¹, [2]

The **improvement in wear resistance** is as a result of five-main phenomena:

1. The **reduction** or elimination of **retained austenite (γ_R)**
2. **Increased precipitation**
3. **Refinement** of secondary carbide
4. **Homogeneous** the microstructure
5. **Augmentation of volume fraction of carbide.**

Carbide Effect on Fracture Toughness



Hahn and Rosenfield's strain criterion

$$K_{IC} \equiv \sqrt{J_{IC} \times E} = \sqrt{E \cdot \sigma_{YS} \cdot \epsilon_f \cdot l_o}$$

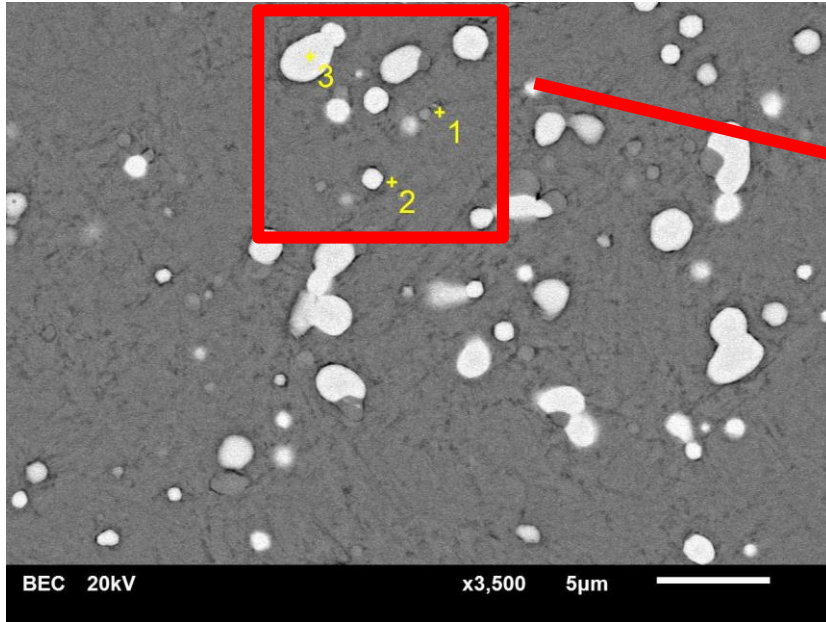
J_{IC} is the critical J integral,
 E is Young's modulus in plane stress,
 σ_{YS} is the yield stress,
 ϵ_f is the equivalent critical local fracture strain,
 l_o is the characteristic microstructural distance for fracture.

The formation of microvoids next to particles (inclusions, precipitates) within the region of intense plastic strain at the crack tip

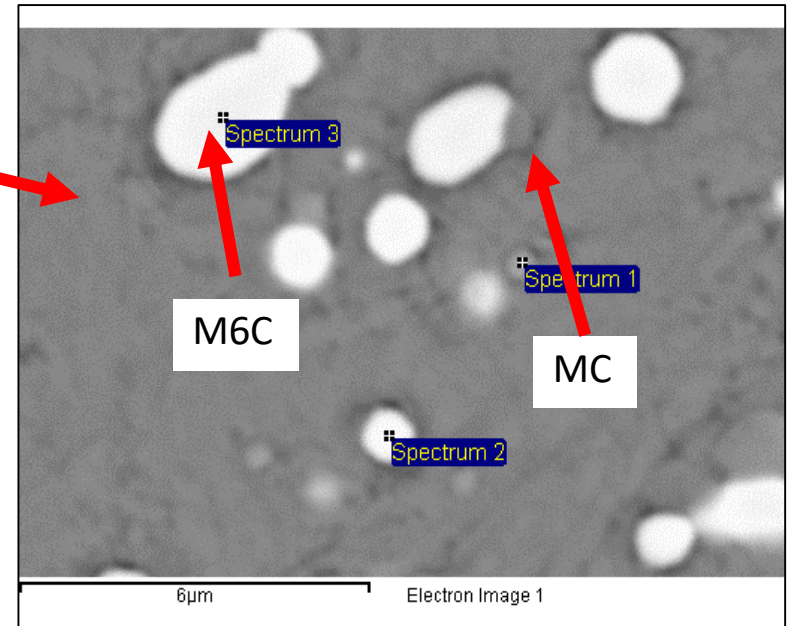
Many literatures reported that the *fracture toughness decrease* when *decreasing of the distance between these particles* described as $K_{IC} \propto f^{-1/6}$

$$K_{IC} = \sqrt{E \cdot \sigma_{YS} \cdot \epsilon_f \cdot d_p \cdot f^{-1/6}}$$

SEM & EDS results of SKH51



SEM micrograph of Microstructure of SKH51 before cryogenic treatment



Microstructure of SKH51 before cryogenic treatment

EDS results of SKH51 (%wt.)

Spectrum	C	O	V	Cr	Fe	Mo	W	Total
Spectrum 1	12.53		14.20	3.86	45.12	10.55	13.74	100.00
Spectrum 2	5.67	2.29	2.22	3.47	40.70	17.57	28.08	100.00
Spectrum 3	4.95	1.71	2.87	3.00	28.94	23.71	34.80	100.00

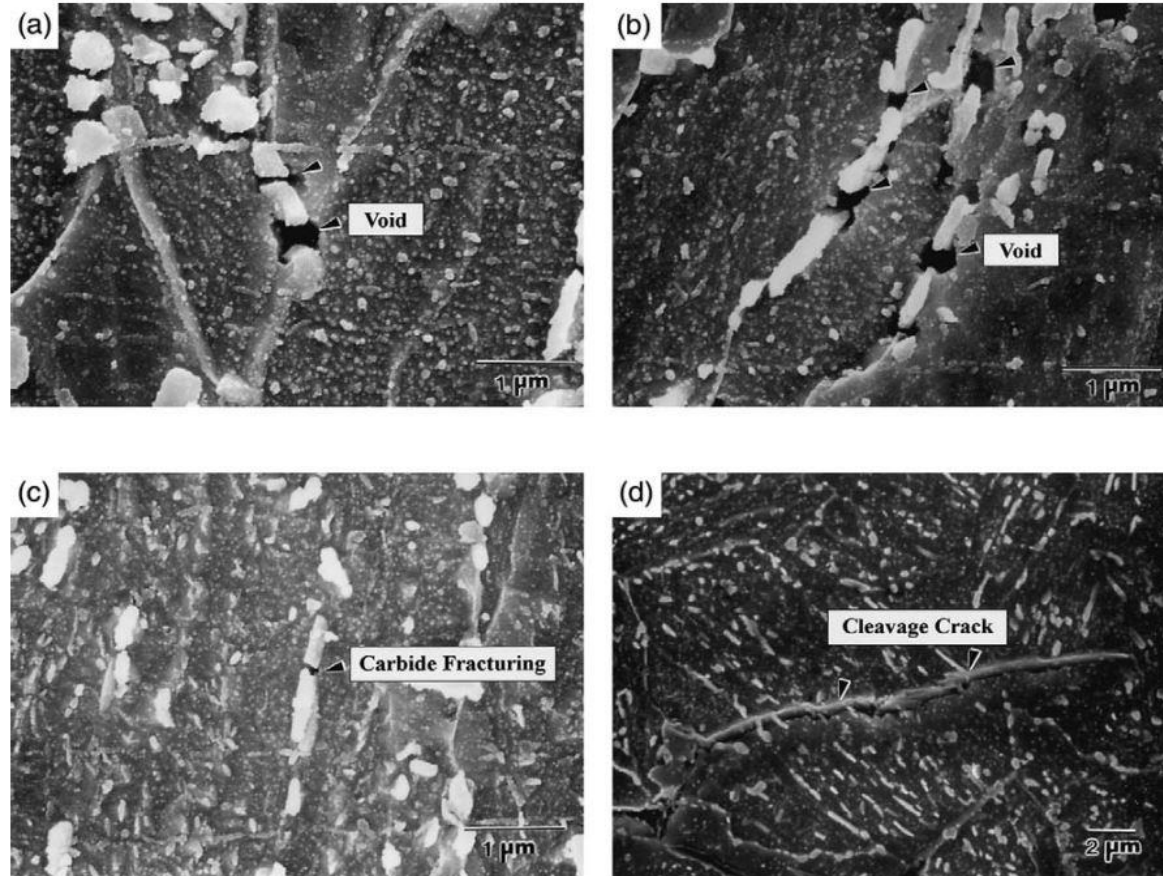
MC is Vanadium Carbide (VC)

M₆C is (Fe,Mo)₃W₃C

Chemical compositions of SKH51 (%wt.)

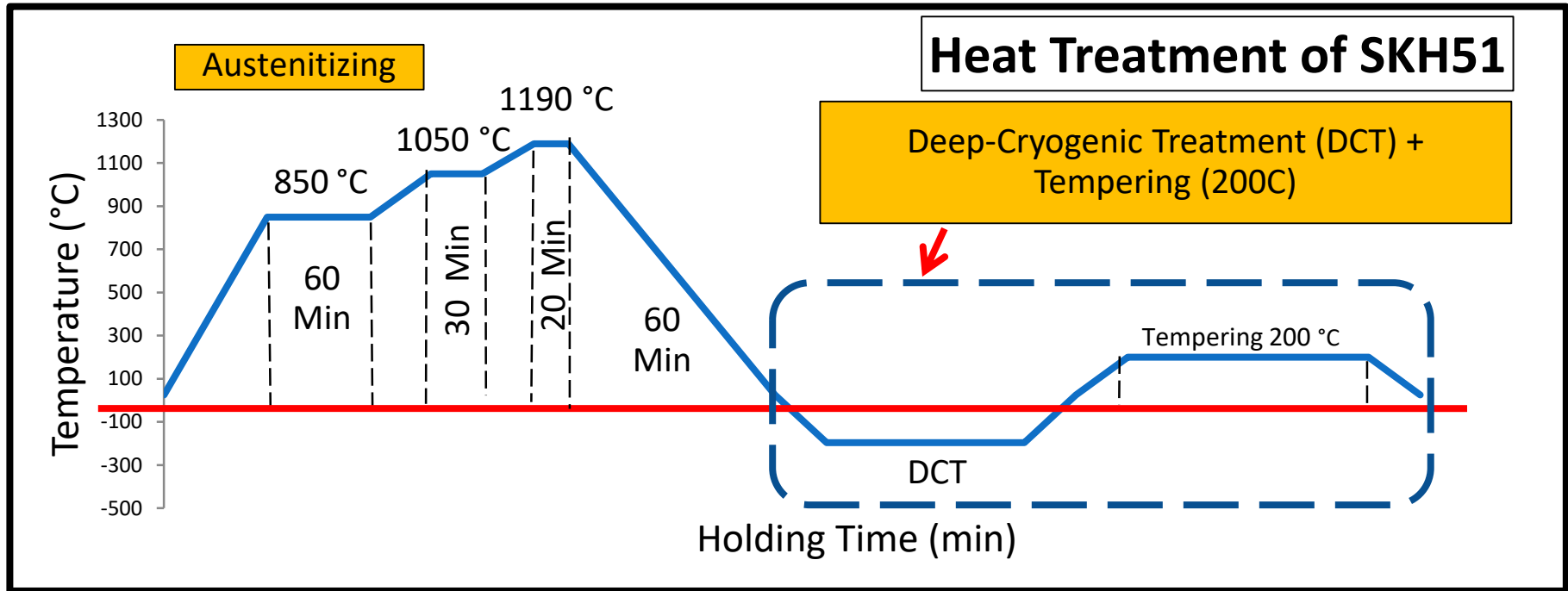
C	Si	Mn	Cr	W	Mo	V	Co
0.94	0.31	0.29	3.78	5.85	4.67	1.75	0.55

Carbide Types Effect



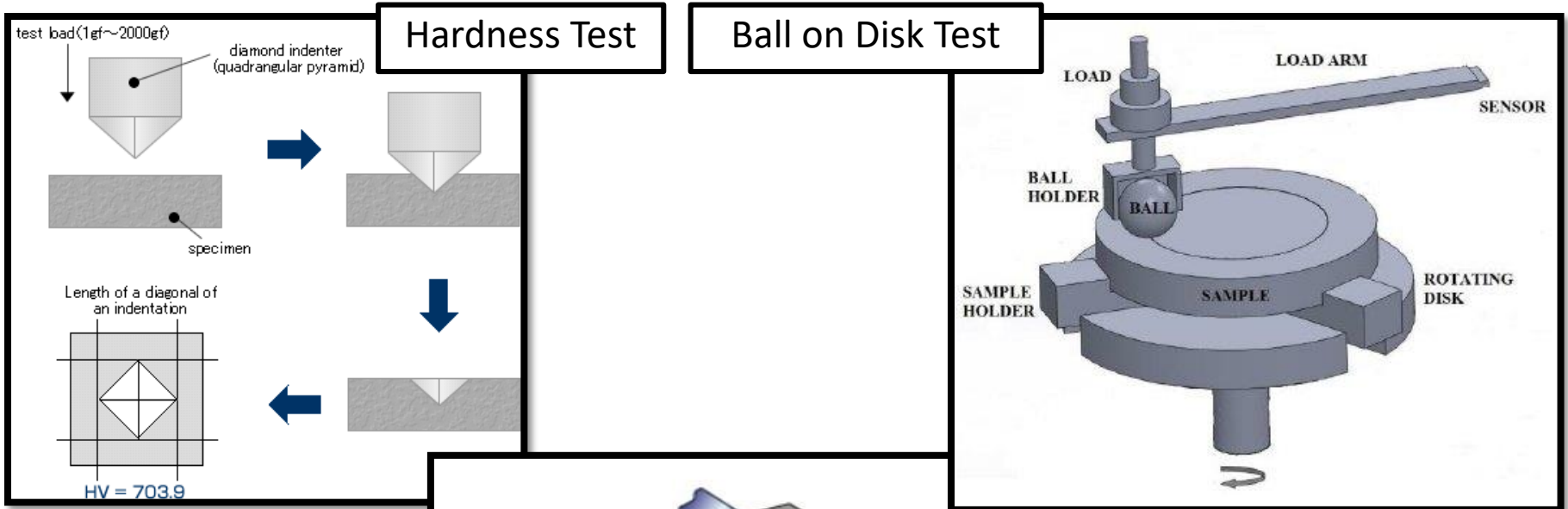
SEM micrographs of the cross-sectioned area beneath the fracture surface of the circumferentially notched tensile specimen tested (a) and (b) at -75 C and (c) and (d) at -140 C, showing the cracking and void initiation at carbides. The tensile axis is vertical for the micrographs. Nital etched. [1]

Heat Treatment Profile of DCT Analysis

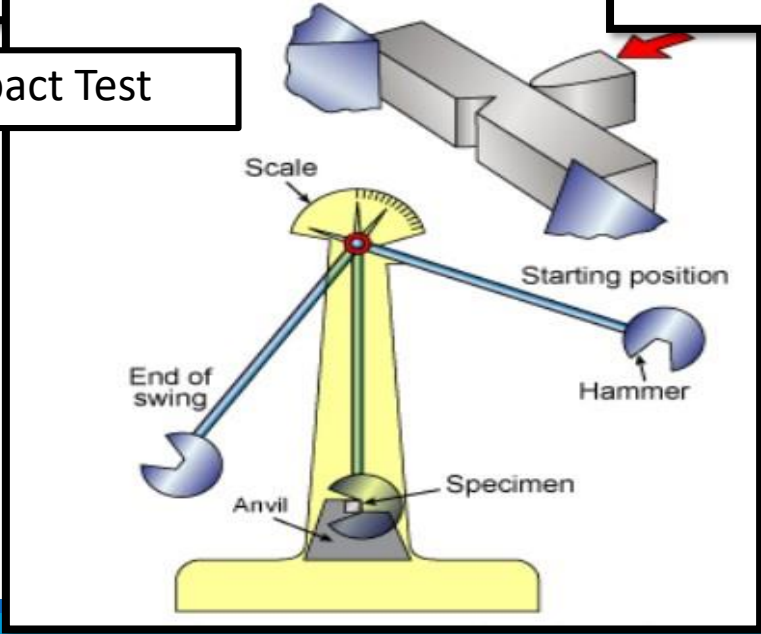


DCT condition investigated in this research				
No.	Name	DCT Temperature (°C)	DCT Holding time (Hr)	Tempering temperature (°C)
1	-140x12_T200	-140	12	200
2	-200x12_T200	-200	12	200
3	-140x36_T200	-140	36	200
4	-200x36_T200	-200	36	200

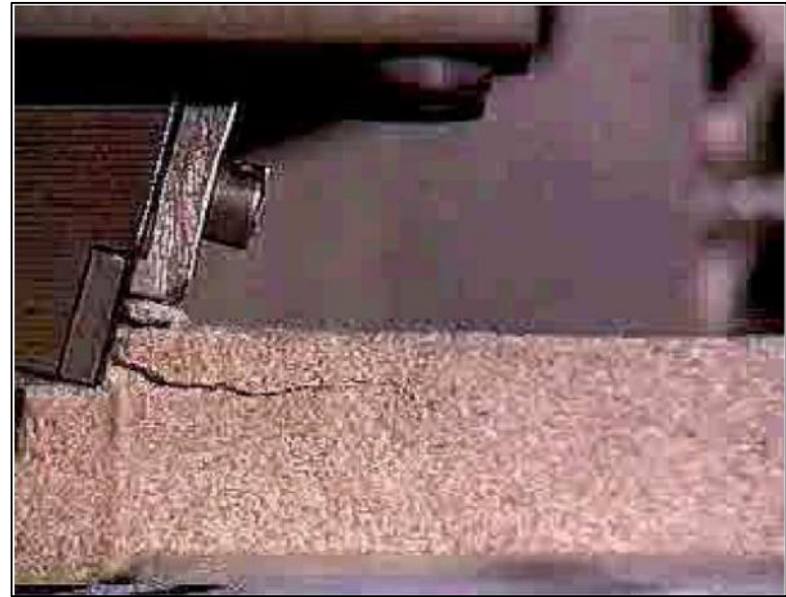
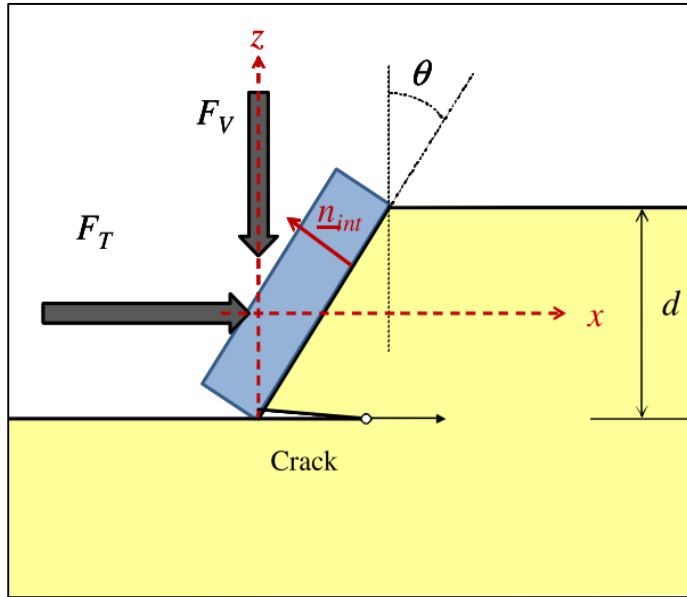
Mechanical Testing



Charpy Impact Test



Scratch test for K1C Determination

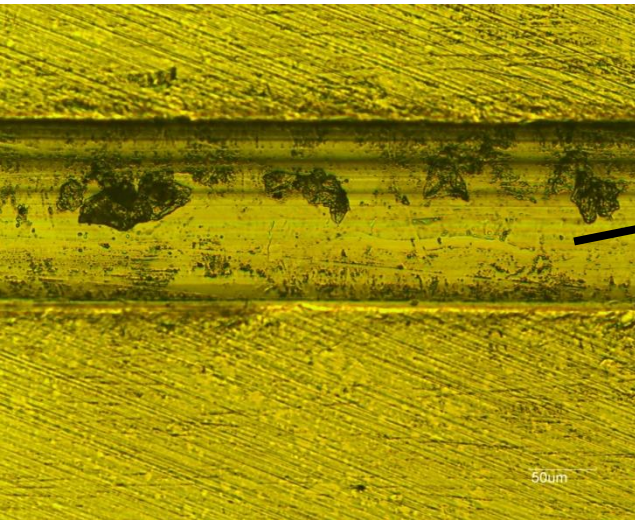


$$J = \oint \left(\psi n_x - T(\underline{n}) \cdot \frac{\partial \xi}{\partial x} \right) ds = - \int_{z=-d/2}^{z=d/2} \left(\psi + \frac{1}{\cos \theta} T(\underline{n}_{int}) \cdot \frac{\partial \xi}{\partial x} \right) dz$$

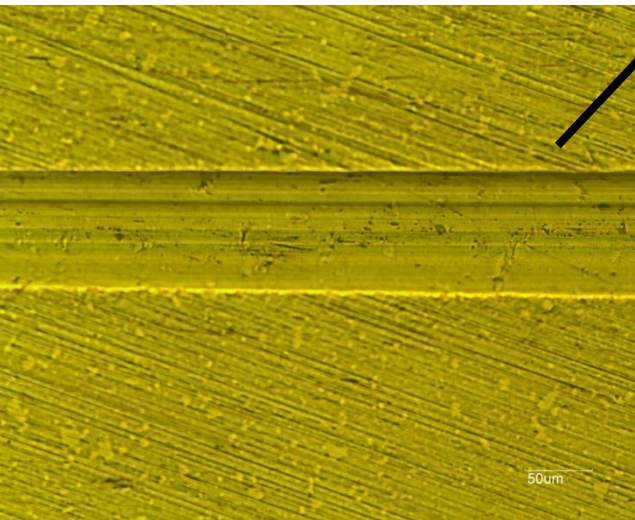
Free energy contribution

Displacement-gradient contribution

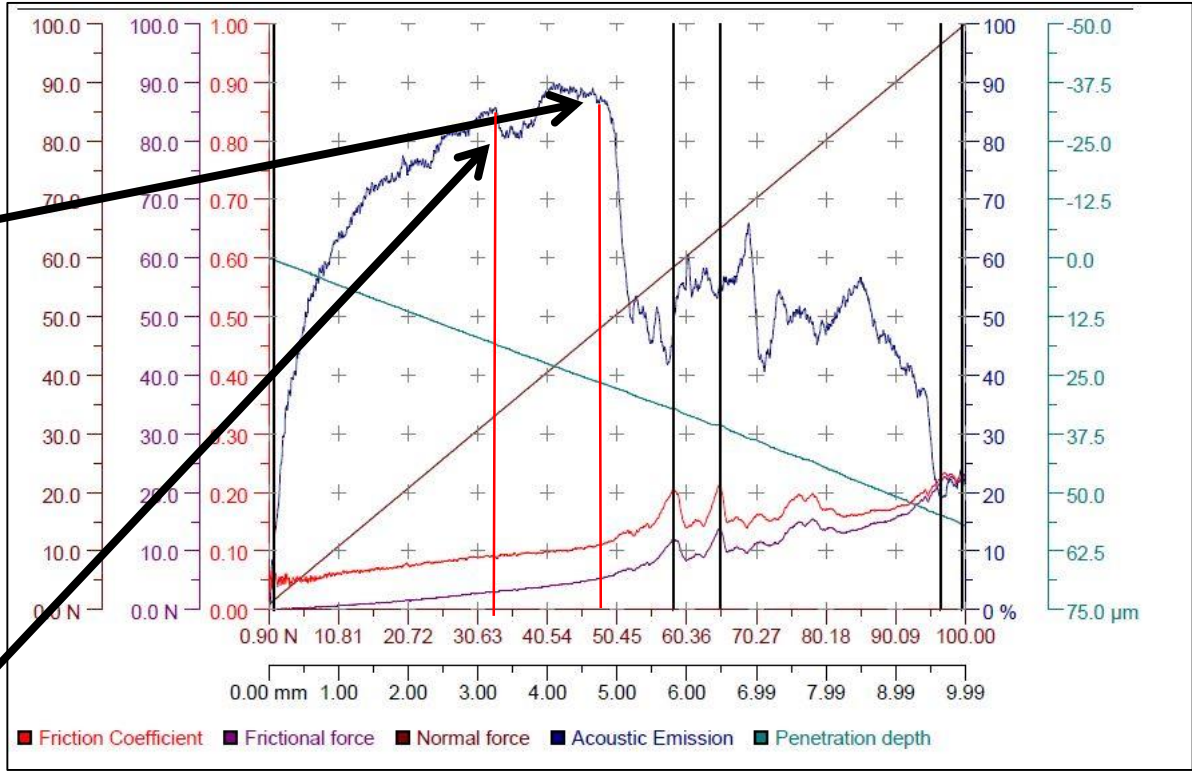
Ft and Penetration Depth Selected Based on Acoustic Emission Signal



Crack results from Scratch test at AE Sudden change

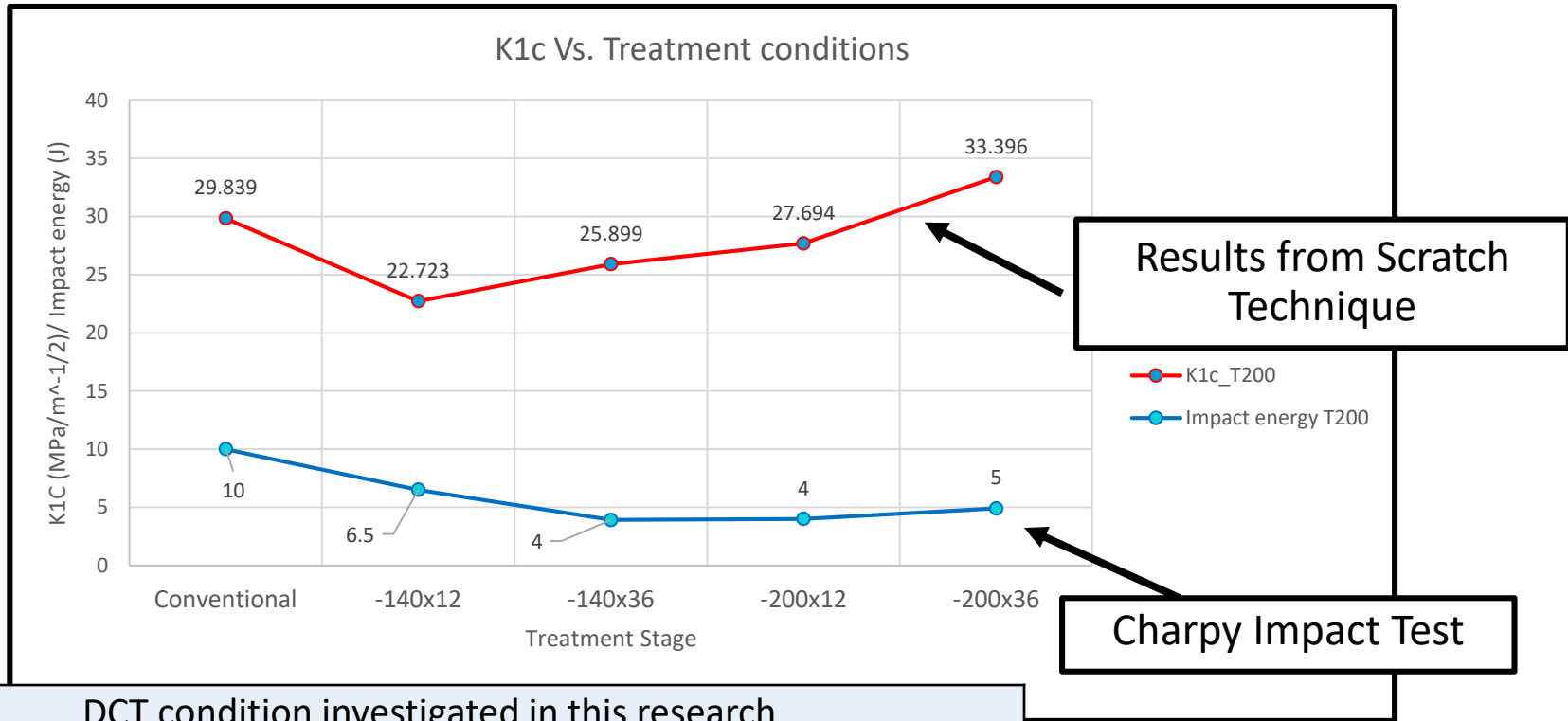


Scratch Line



Results from the Scratch test

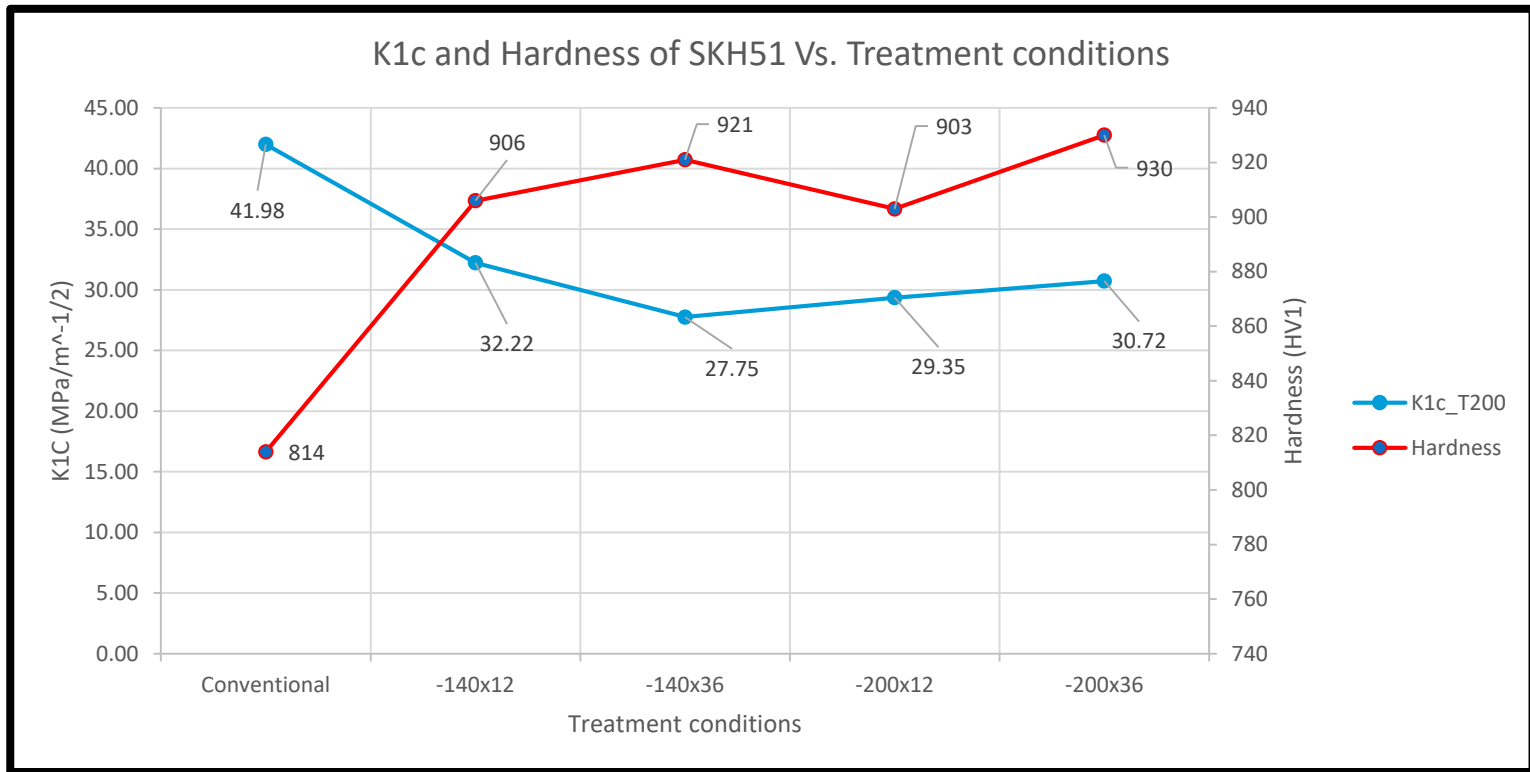
Scratch Testing Vs Charpy Impact Test



DCT condition investigated in this research				
No.	Name	DCT Temperature (°C)	DCT Holding time (Hr)	Tempering temperature (°C)
1	-140x12_T200	-140	12	200
2	-200x12_T200	-200	12	200
3	-140x36_T200	-140	36	200
4	-200x36_T200	-200	36	200

Chemical compositions (wt%)								
	C	Si	Mn	Cr	Mo	Ni	V	Fe
YXR3	0.62	1.36	0.41	4.15	2.55	0.06	1.69	88.7

DCT Parameters Effect on SKH51



Hardness

- SKH51 → 814 HV → 930 HV (↑ 15% Increase)

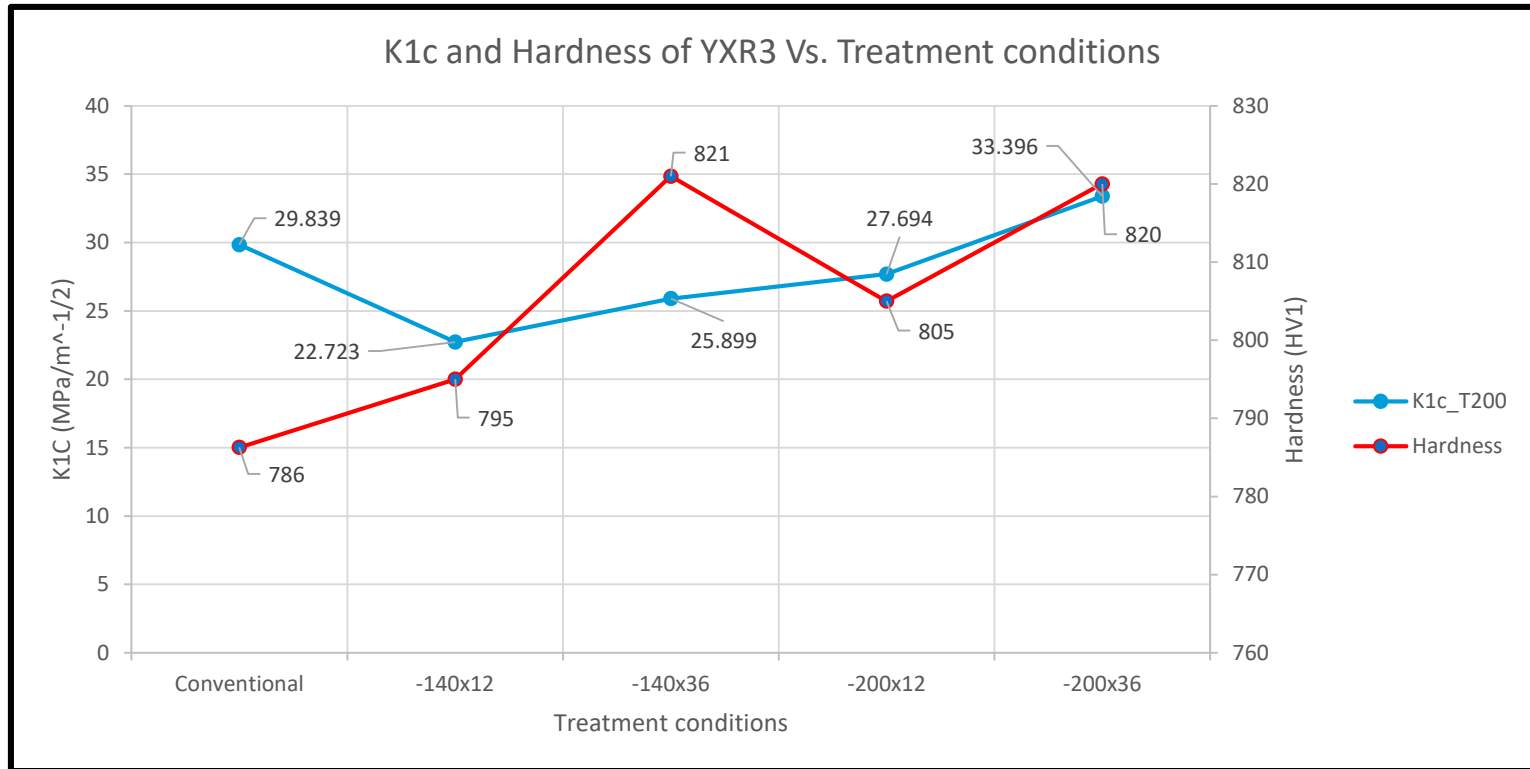
Toughness

- SKH51 → 42 → 30 Mpa/m^{-1/2} (↓ 30% Decrease)

Chemical compositions (wt%)

	C	Si	Mn	Cr	Mo	Ni	V	Fe
SKH51 (AISI M2)	0.94	0.31	0.29	3.78	4.67	0.26	1.75	79.9

DCT Parameters Effect on YXR3



Hardness

- YXR3 → 786 HV → 820 HV (↑ 15% increase)

Toughness

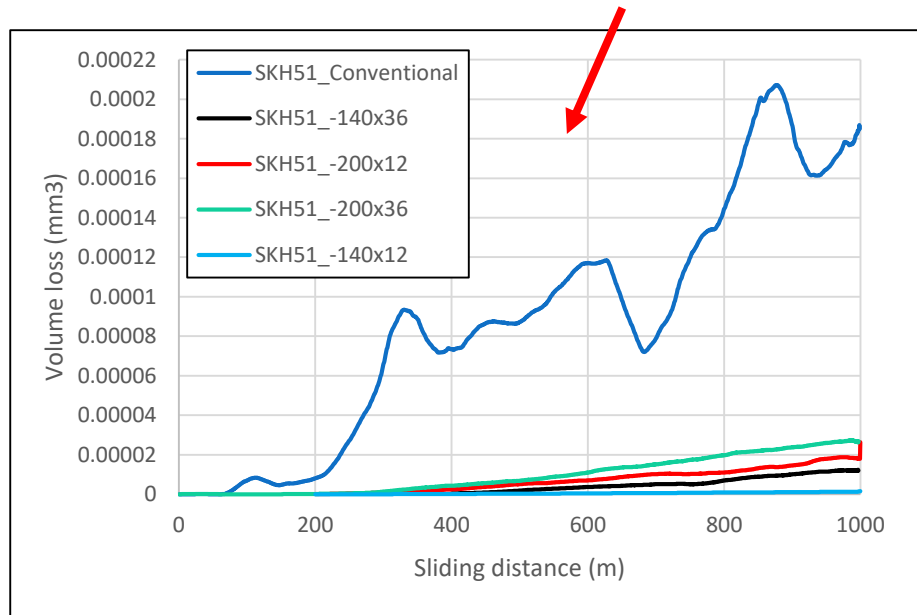
- SKH51 → 30 → 33 MPa/m^{-1/2} (↑ 10% increase)

Chemical compositions (wt%)

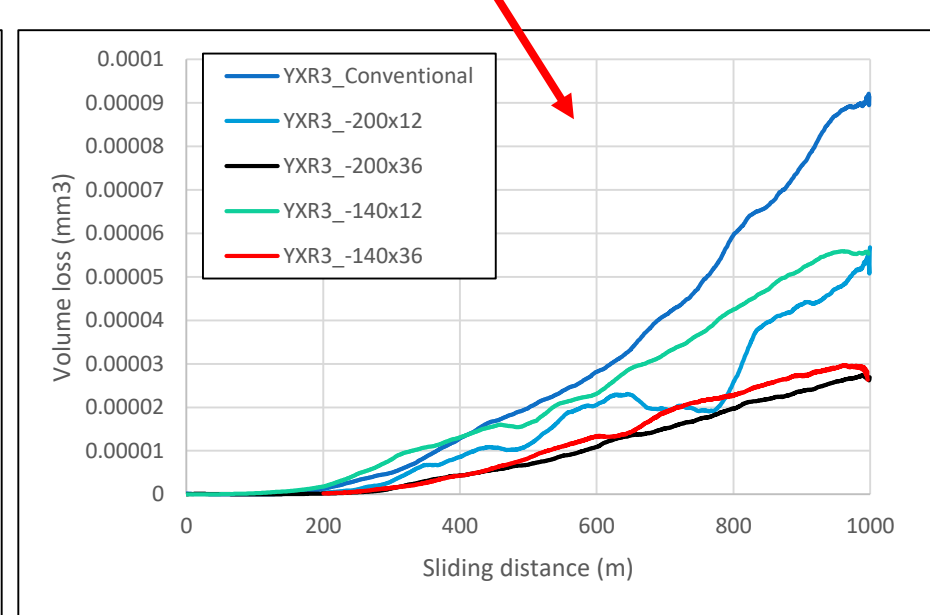
	C	Si	Mn	Cr	Mo	Ni	V	Fe
YXR3	0.62	1.36	0.41	4.15	2.55	0.06	1.69	88.7

Wear Testing Results

	SKH51					YXR3				
	Conventional	-200 °C		-140 °C		Conventional	-200 °C		-140 °C	
		12 hr	36 hr	12 hr	36 hr		12 hr	36 hr	12 hr	36 hr
Wear Rete (mm ³ /m) (x10 ⁻⁸)	11.7	4.00	4.00	3.67	3.00	23.3	9.00	3.33	12.30	4.67
Improvement Percentage (%)	-	66 %	66 %	69 %	74 %	-	61 %	86 %	47 %	80 %

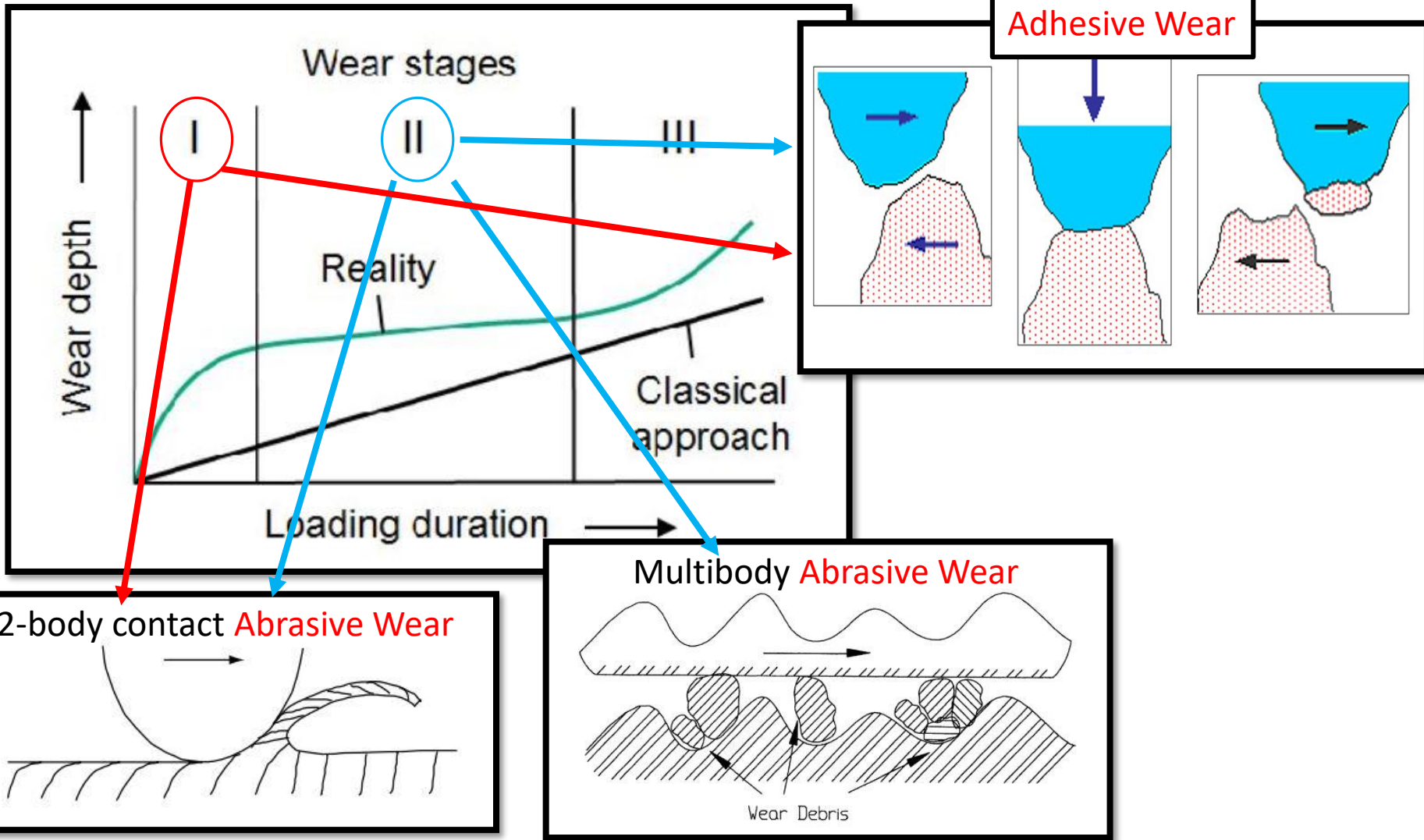


Volume loss of **SKH51** under different DCT conditions



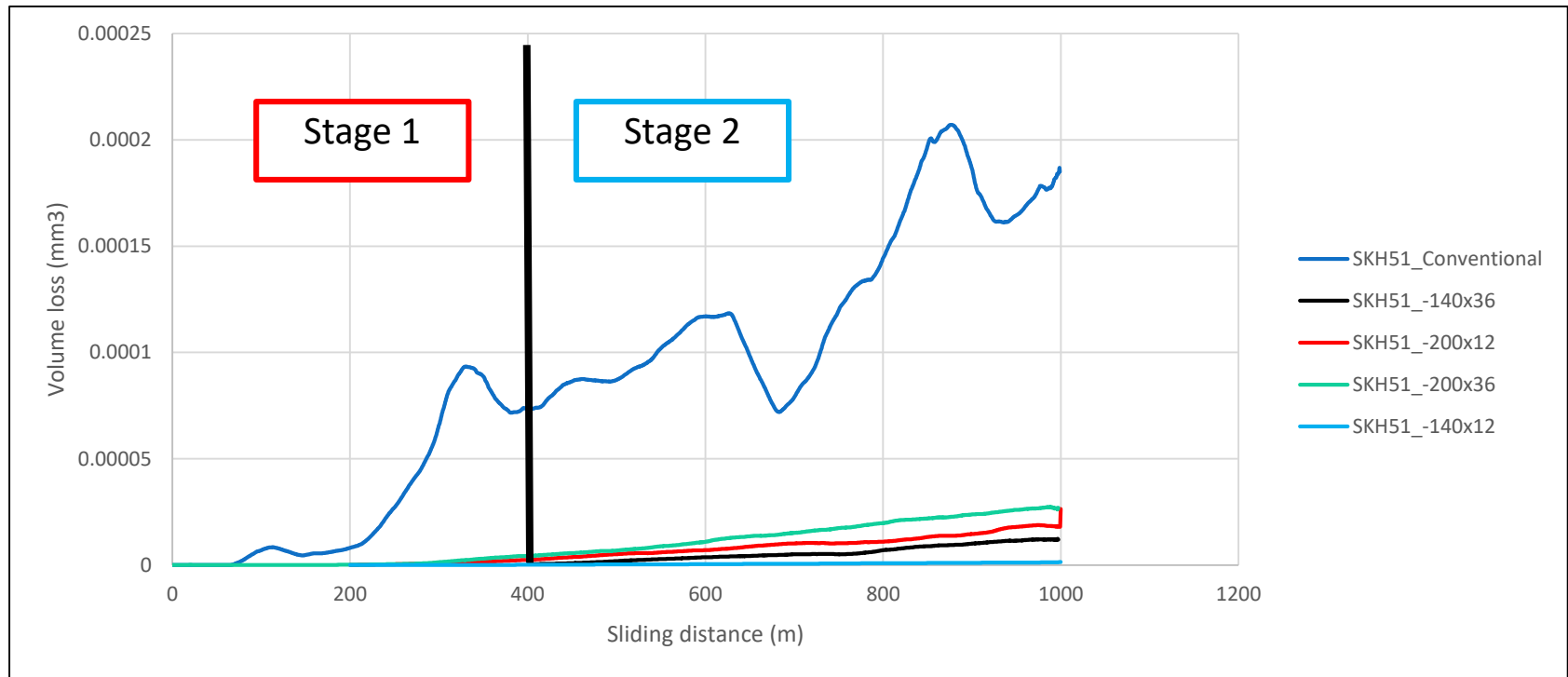
Volume loss of **YXR3** under different DCT conditions

Wear Behavior



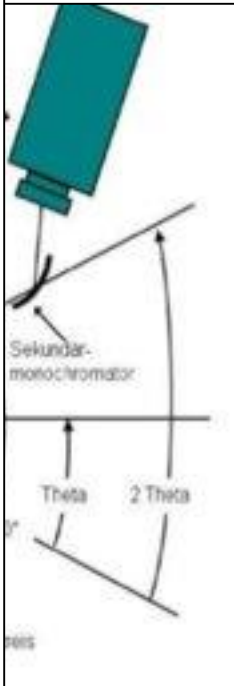
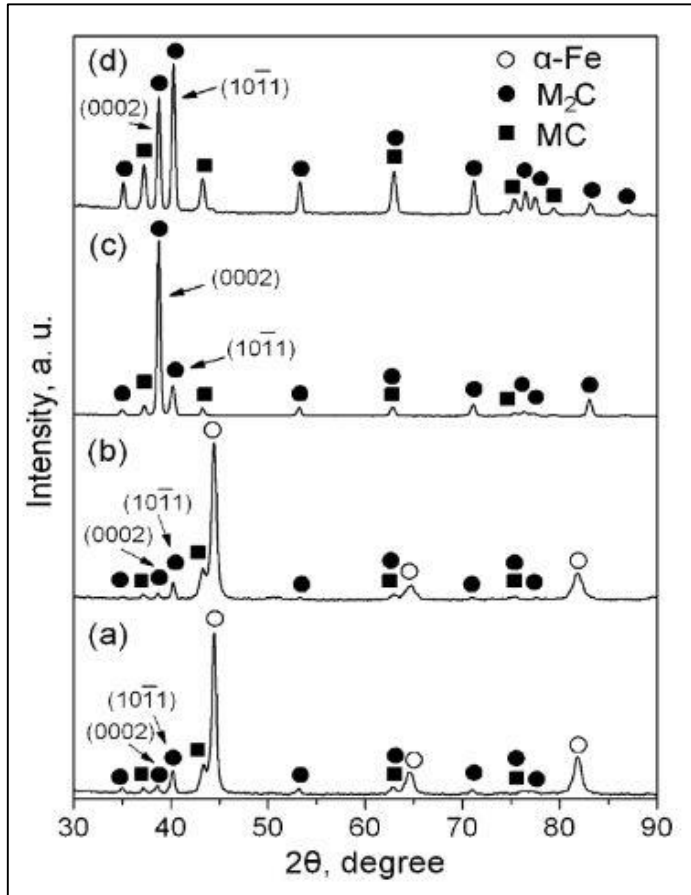
Wear testing Results

	SKH51				
	Conventional treatment	-140 °C		-200 °C	
		12 hr	36 hr	12 hr	36 hr
Wear Rete (mm ³ /m) (x10 ⁻⁸)	11.7	3.67	3.00	4.00	4.00
Improvement Percentage (%)	-	69 %	74 %	66 %	66 %

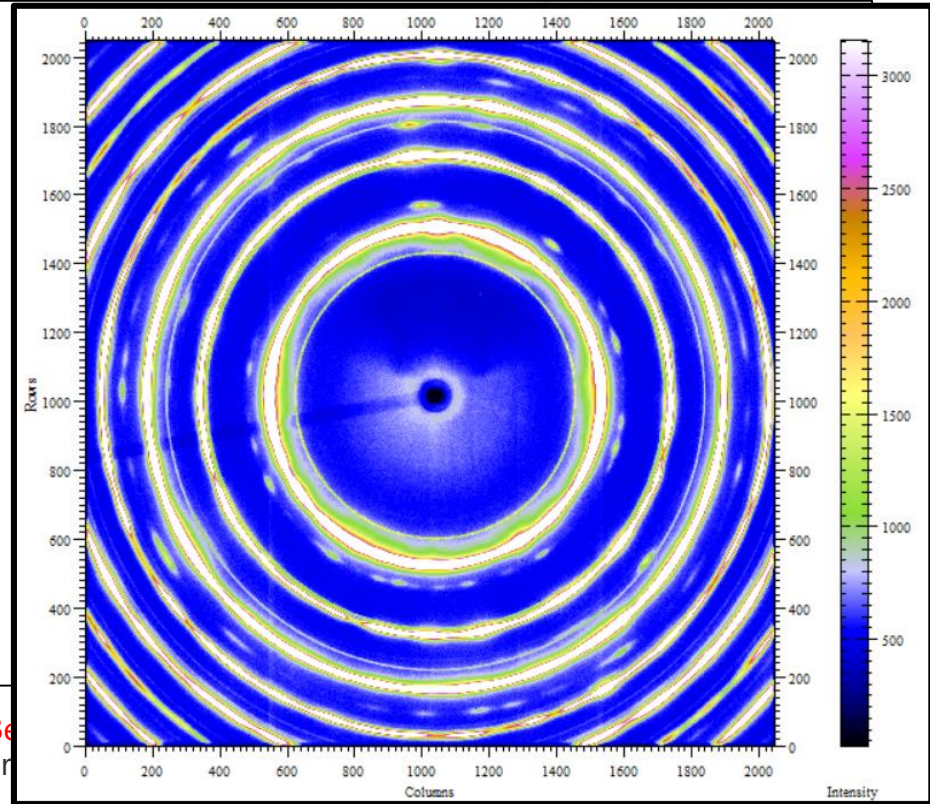


Volume loss of SKH51 under different DCT conditions

What is X-ray Diffraction ?

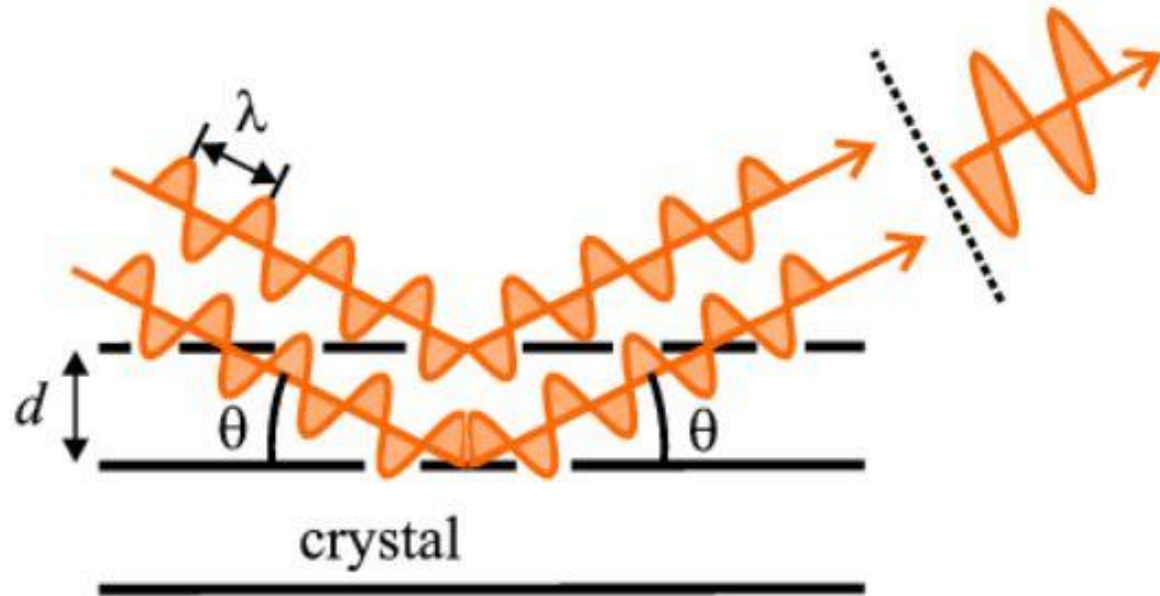


Setup; (a) Bragg-Brentano
definite crystal



XRD is a technique used for determining the atomic and molecular structure of a crystal.

Basic concept of XRD



$$n \lambda = 2 d \sin \theta$$

Where:

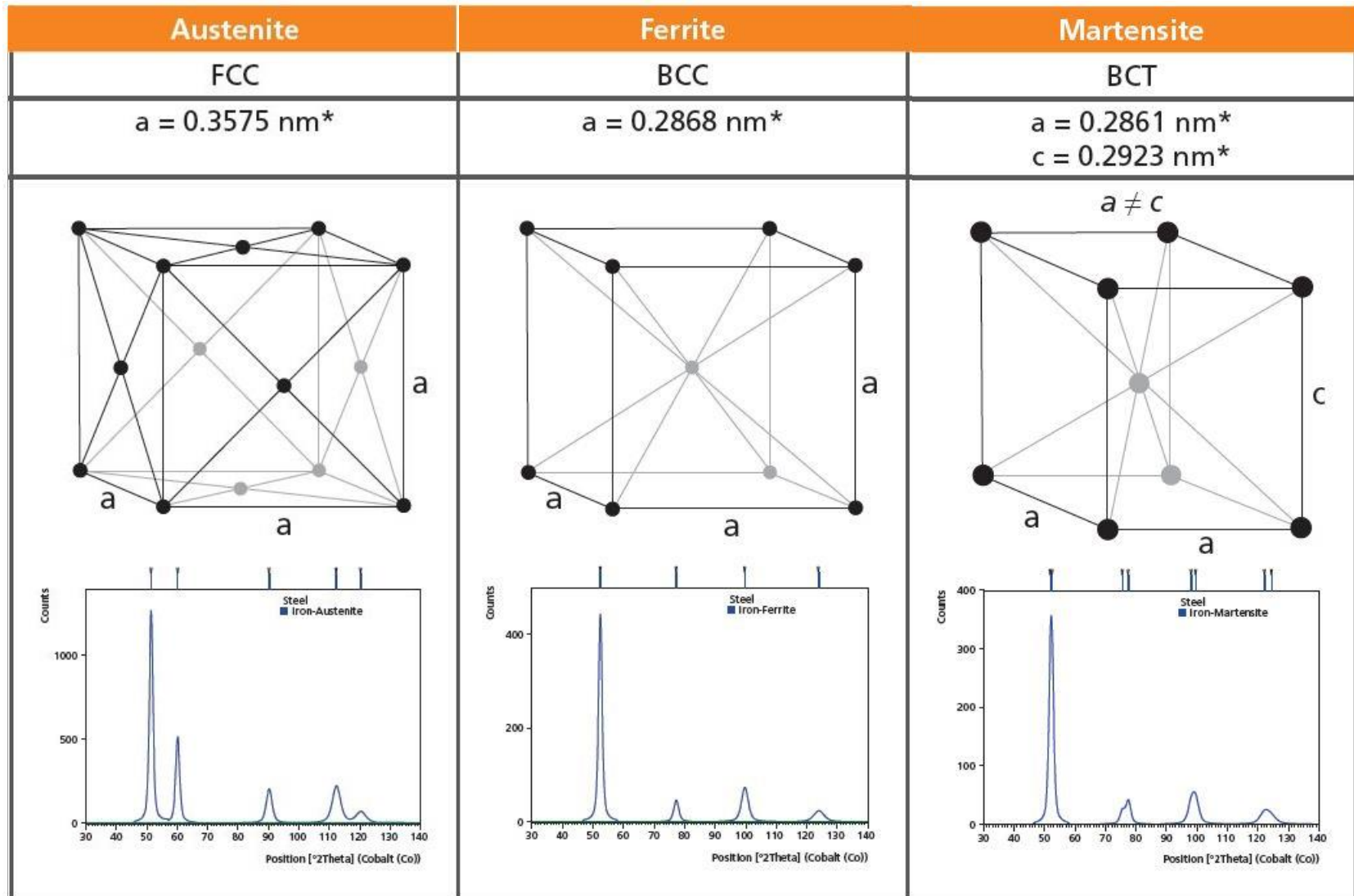
λ is the wavelength of the radiation used,

d is the inter-planar spacing involved.

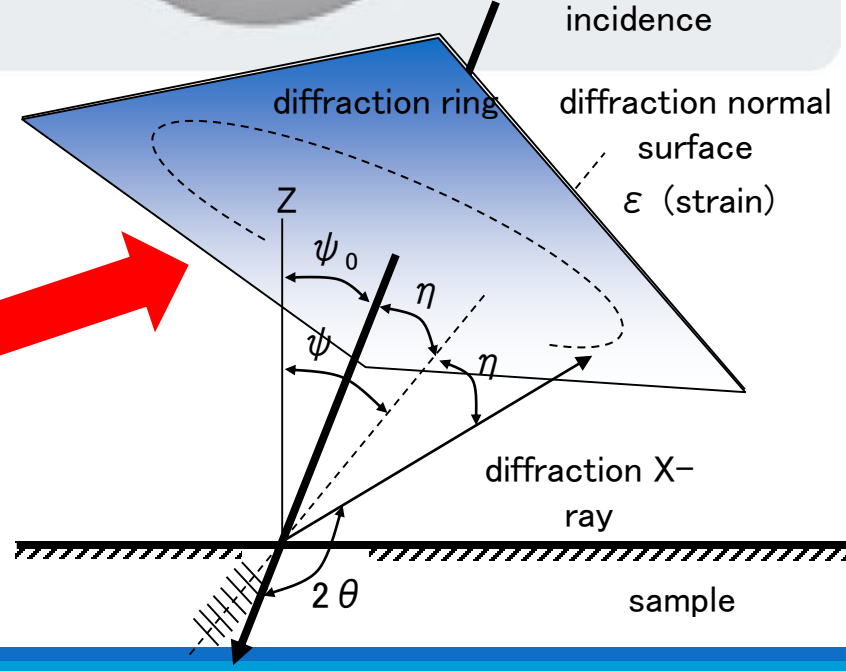
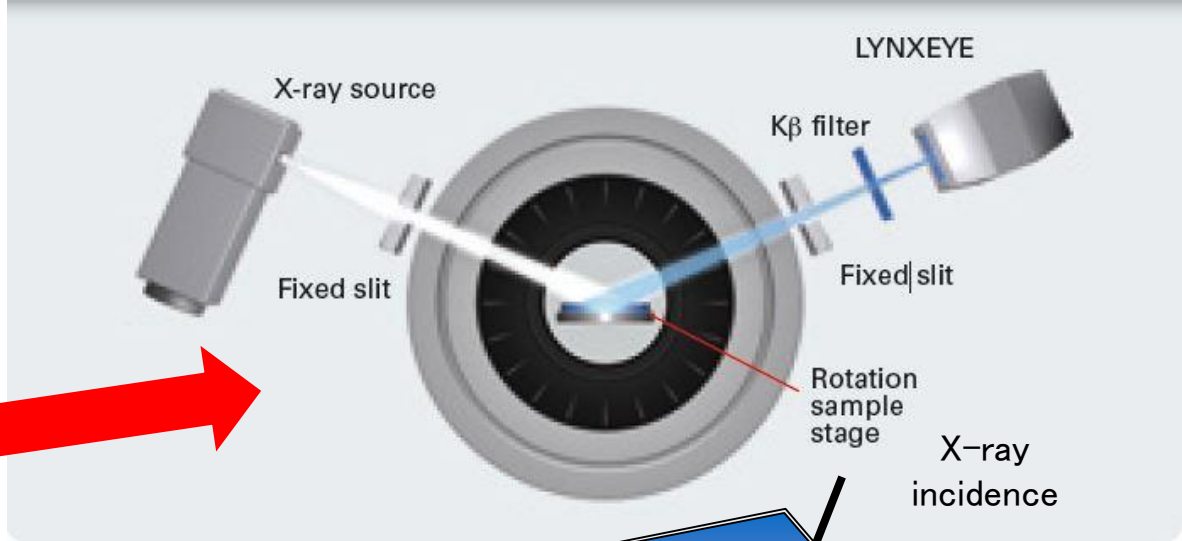
θ is the angle between the incident (or diffracted) ray and the relevant crystal planes.

n is an integer, referred to as the order of diffraction.

Basic concept of XRD

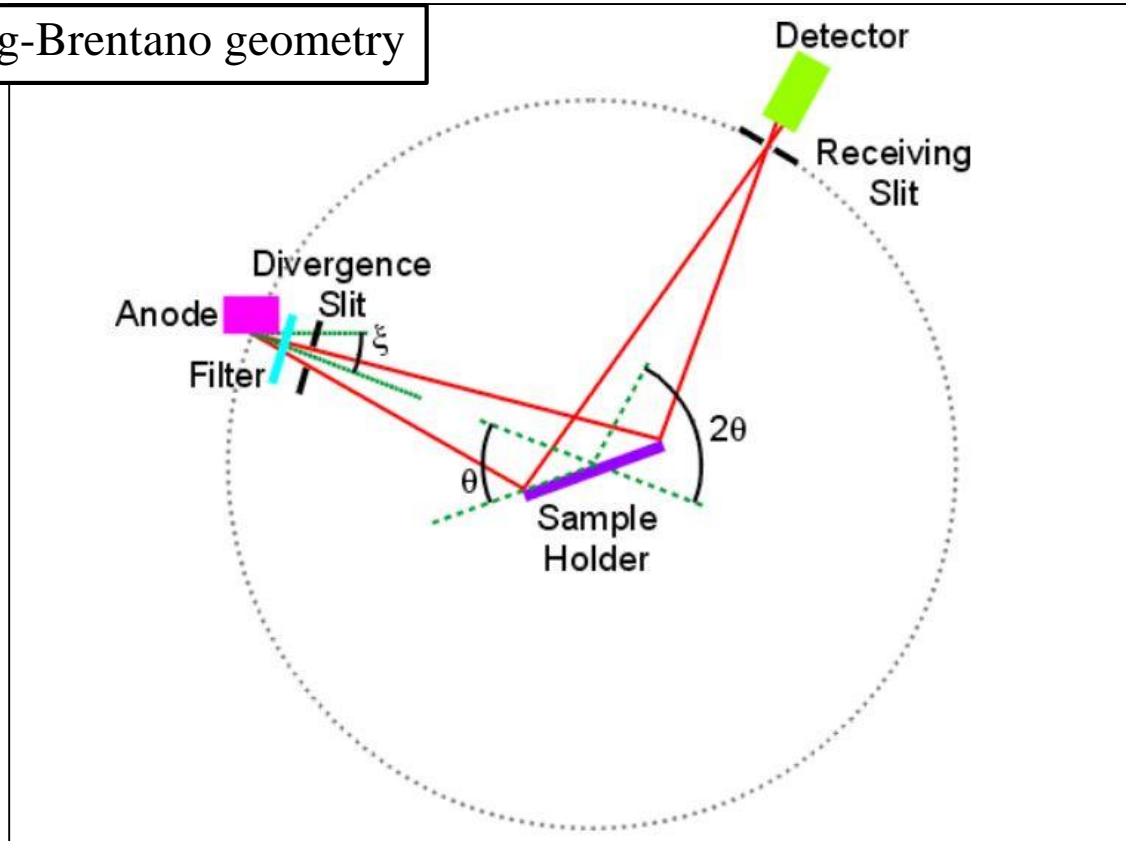


Geometry of an X-Ray Diffractometer



Bragg-Brentano Setup

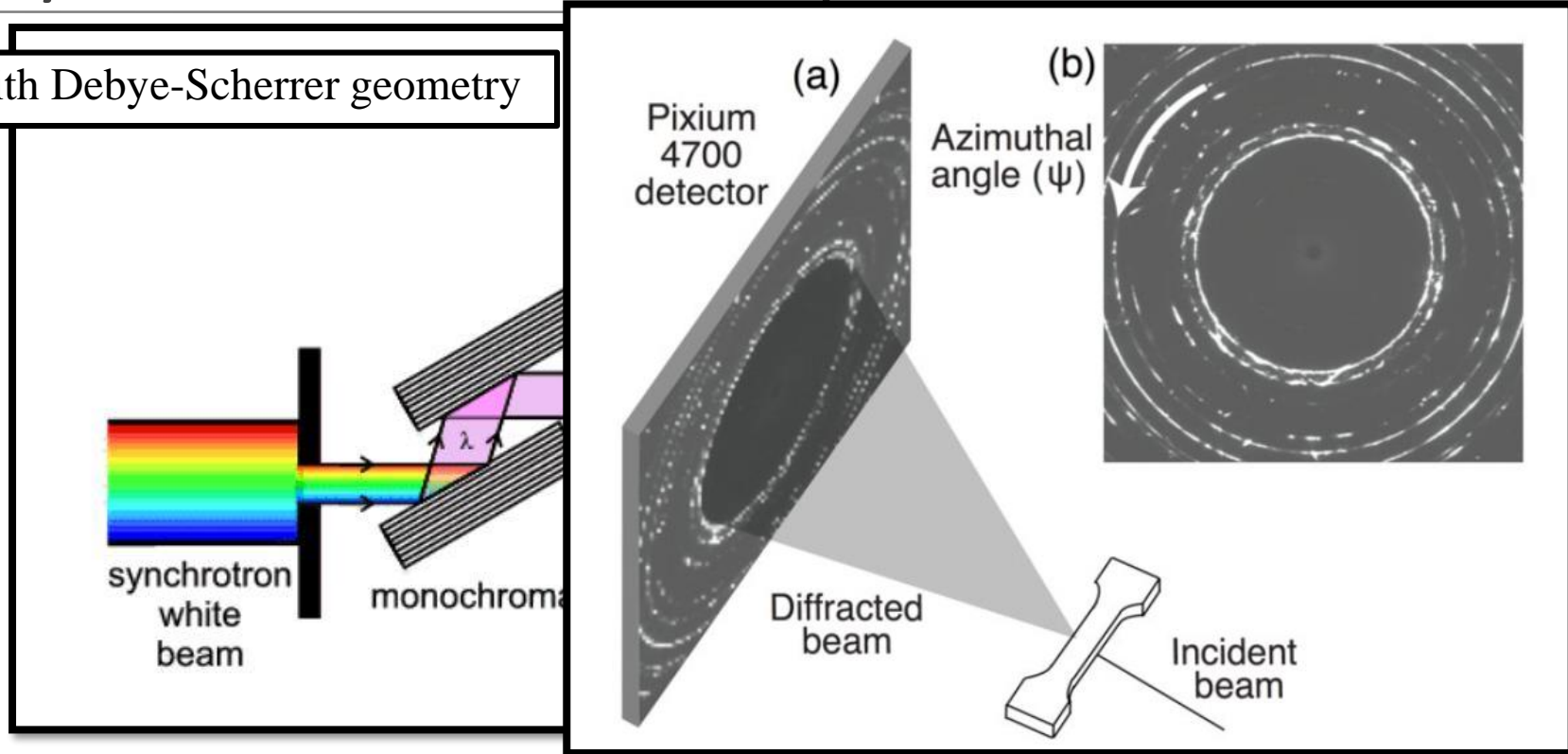
XRD with Bragg-Brentano geometry



The earliest flat-plate diffractometers had poor intensities and peak widths due to lack of focussing. By contrast the modern flat-plate diffractometer has both good peak intensities and excellent resolution due to focussing of the diffracted beam. This reflection geometry, in which the divergent and diffracted beams are focussed at a fixed radius from the sample position, is commonly referred to as **Bragg-Brentano** geometry.

Debye-Scherrer Setup

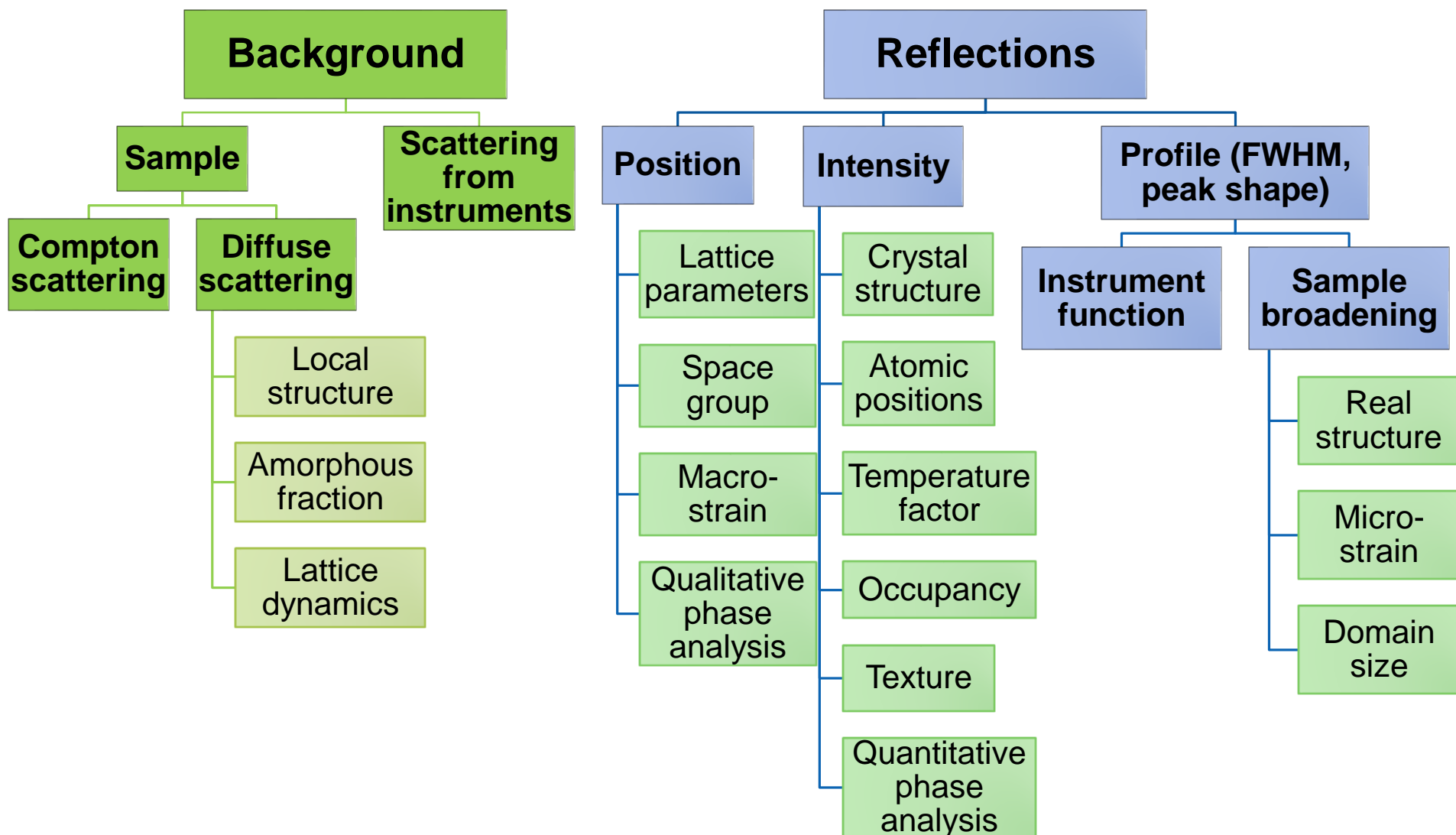
XRD with Debye-Scherrer geometry



The term *Debye-Scherrer* is named after the originators, Debye, Scherrer and Hull, and is one of the oldest known powder diffraction geometries, though originally it was used only with photographic film on a "powder diffraction camera". It uses a near-parallel incident beam of X-rays with sufficient cross-section to bathe the whole powder-sample. One of its virtues is its simplicity as illustrated by the following schematic of the Debye-Scherrer camera/diffractometer.

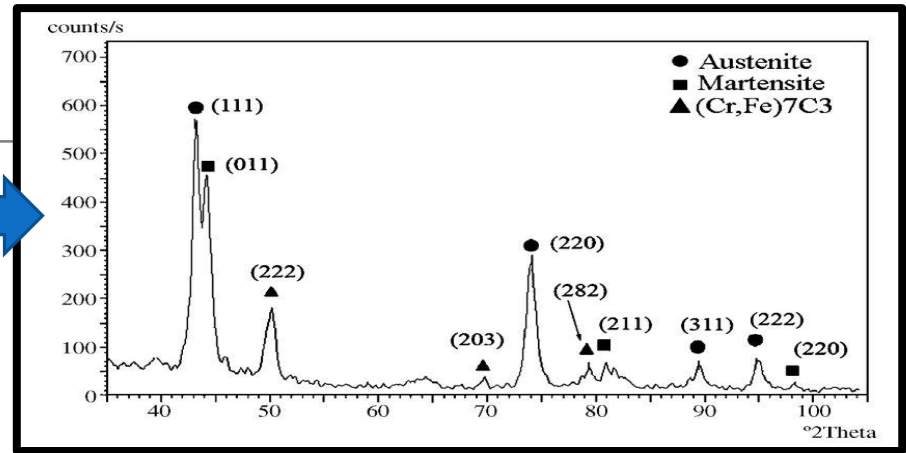
a) Schematic of the synchrotron X-ray diffraction setup, (b) Complete Debye-Scherrer rings from tetragonal martensite

General information content of PXRD data



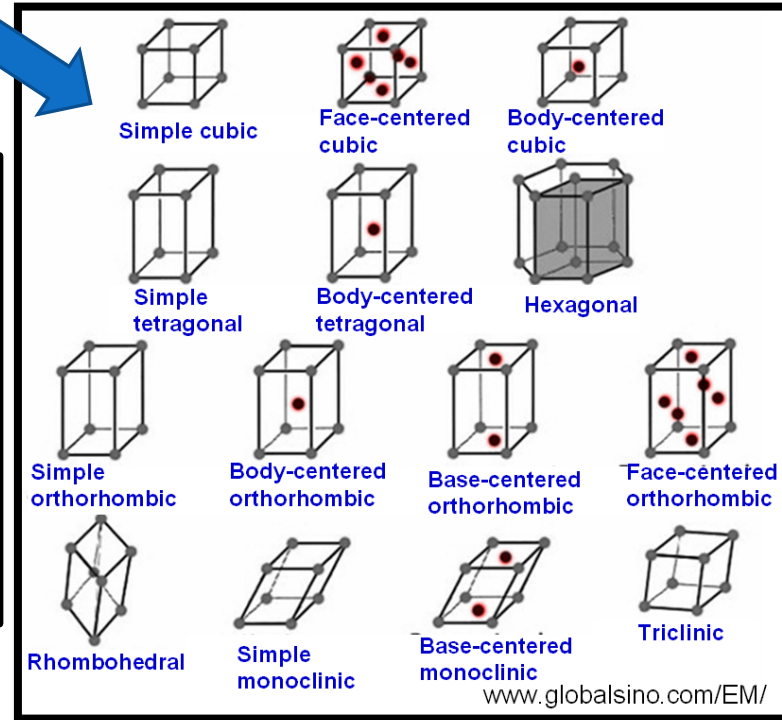
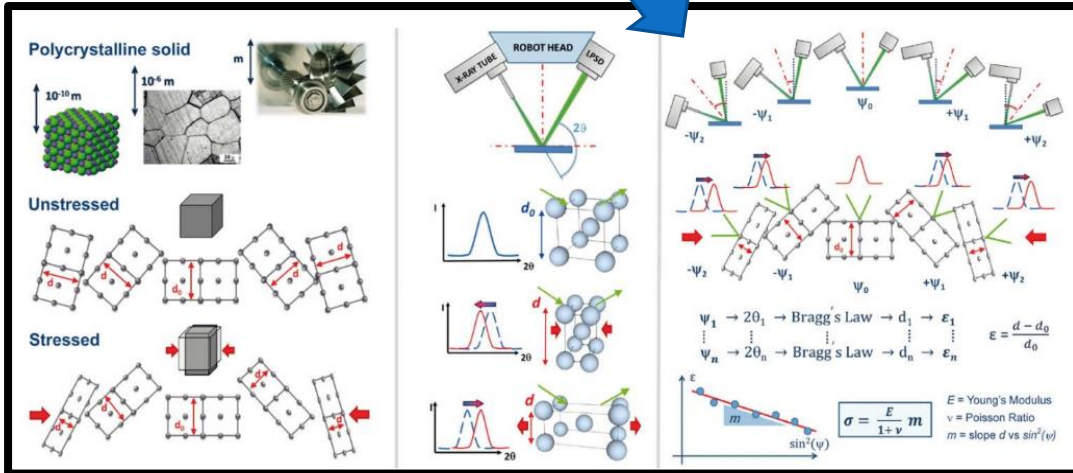
Applications

- Phase Identification

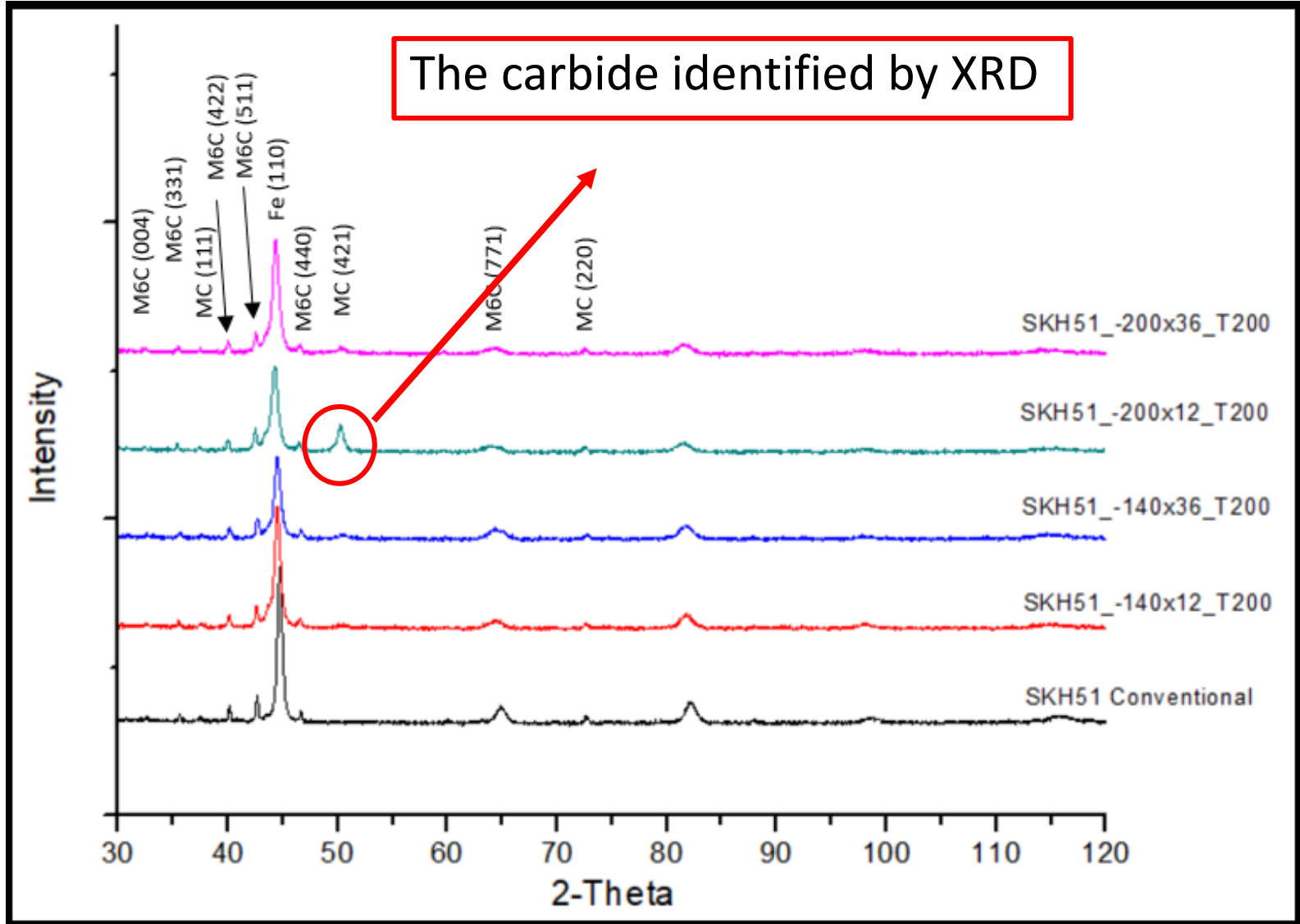


- Unit cell lattice parameters and Bravais lattice symmetry.

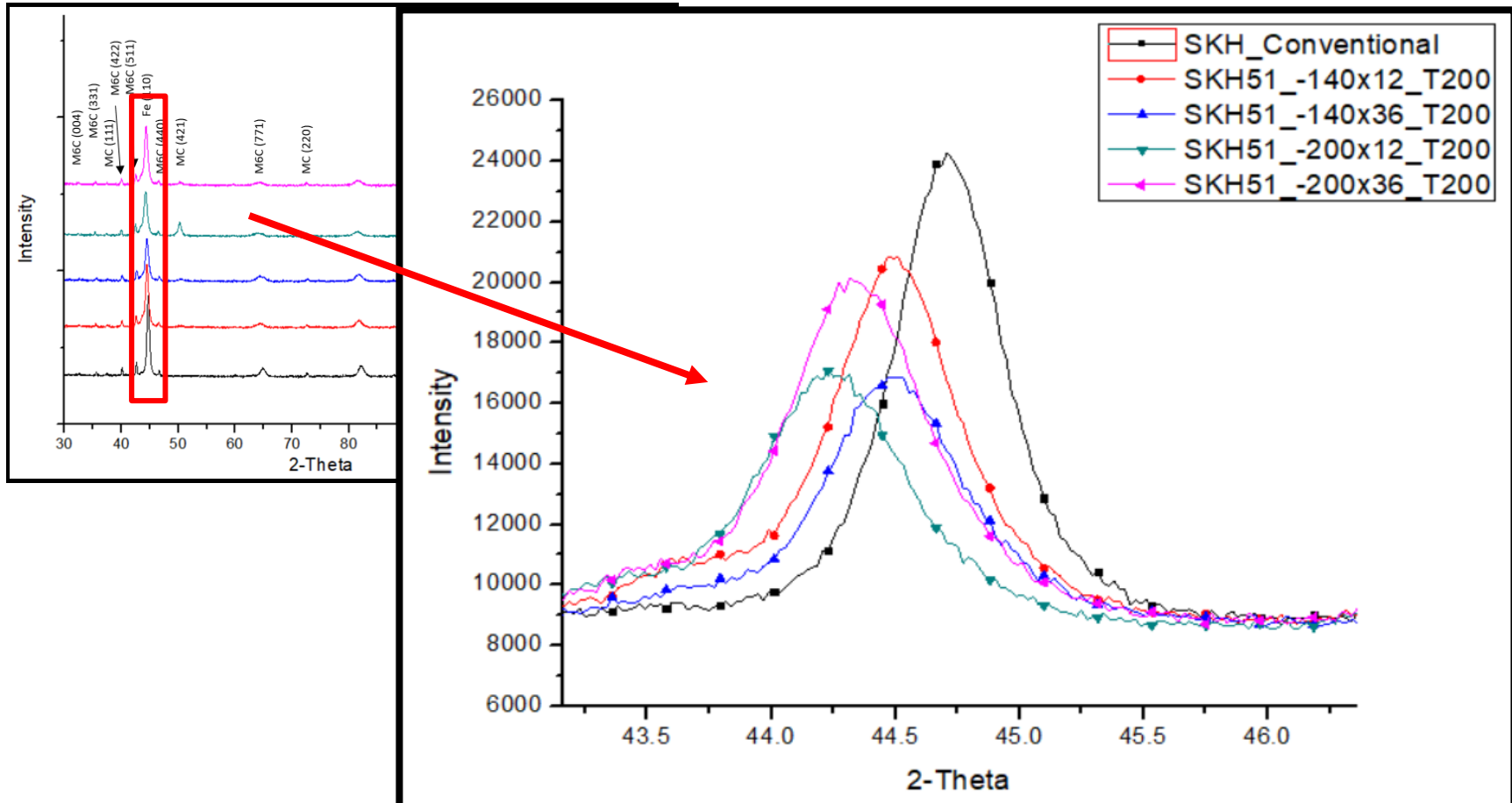
- Residual Stress and Strain



DCT Effect by XRD SKH51

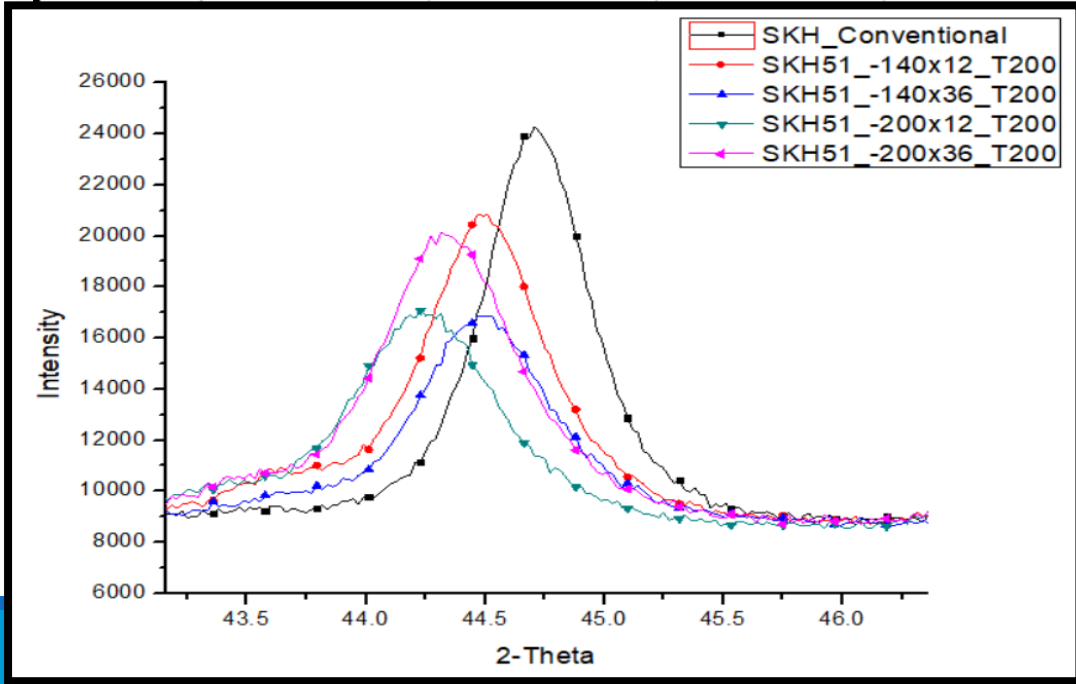
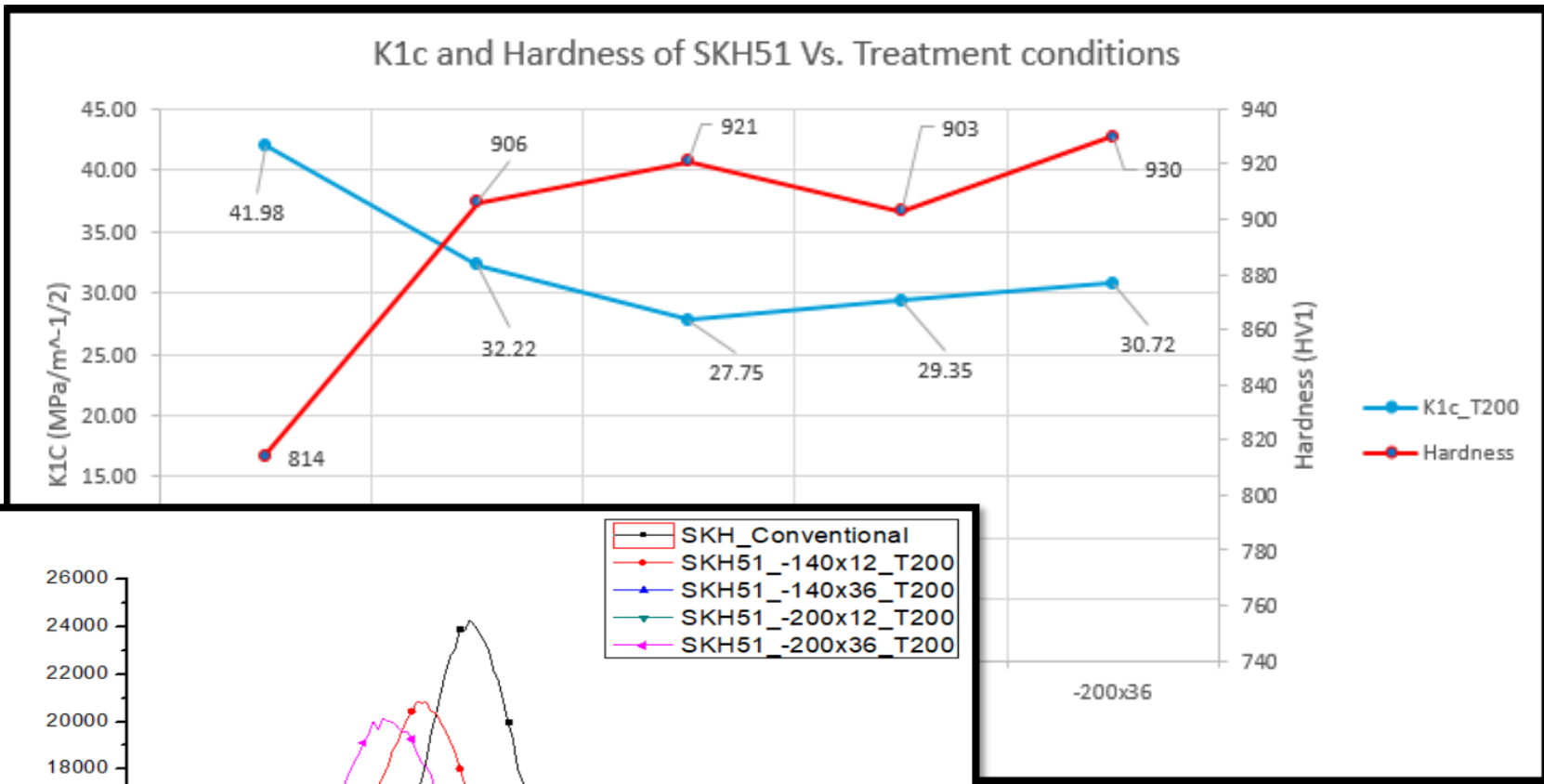


DCT Effect by XRD SKH51



Chemical compositions (wt%)								
	C	Si	Mn	Cr	Mo	Ni	V	Fe
SKH51 (AISI M2)	0.94	0.31	0.29	3.78	4.67	0.26	1.75	79.9

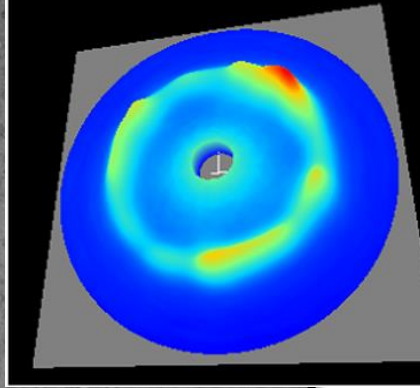
DCT Parameters Effect on SKH51



DCT Effect by XRD SKH51

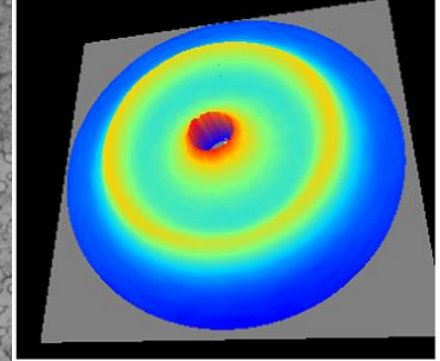
SKH51 Conventional

Debye ring(3D)
Rotation : 0 [deg]



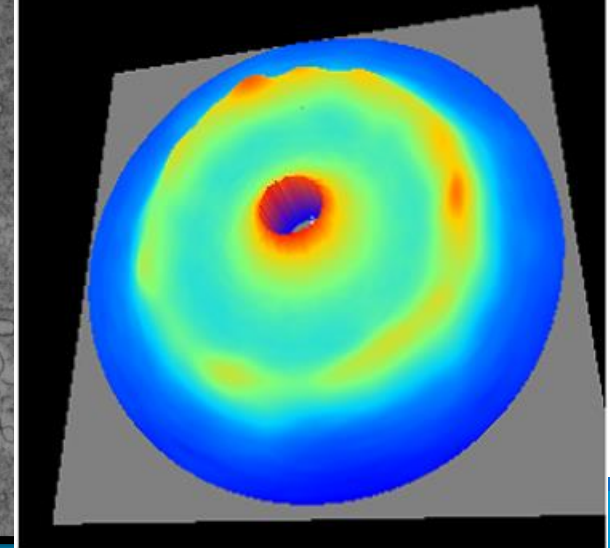
SKH51: -140 C/ 12hr/
200 C Tempering

Debye ring(3D)
Rotation : 0 [deg]



SKH51: -200 C/ 36hr/
200 Tempering

Debye ring(3D)
Rotation : 0 [deg]

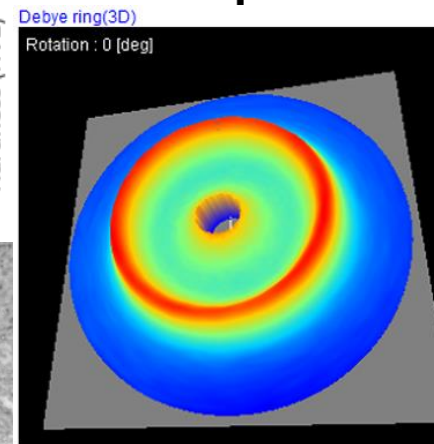
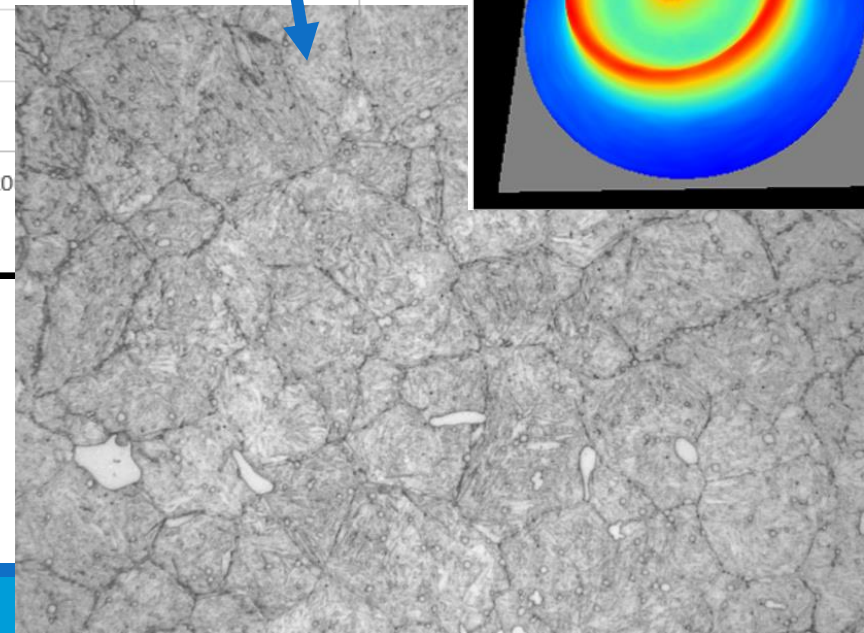
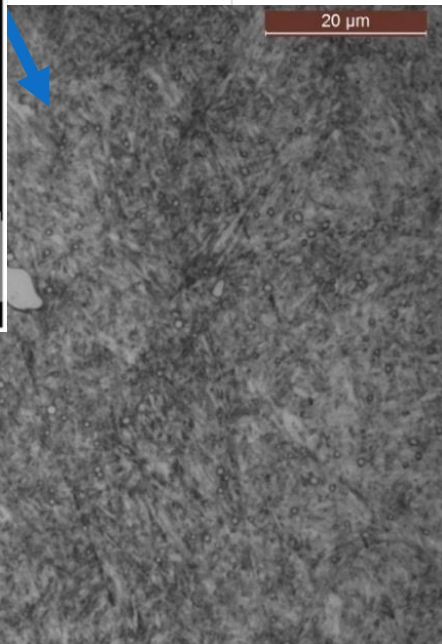
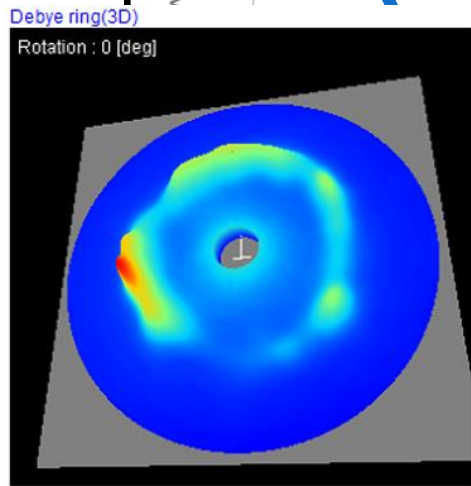
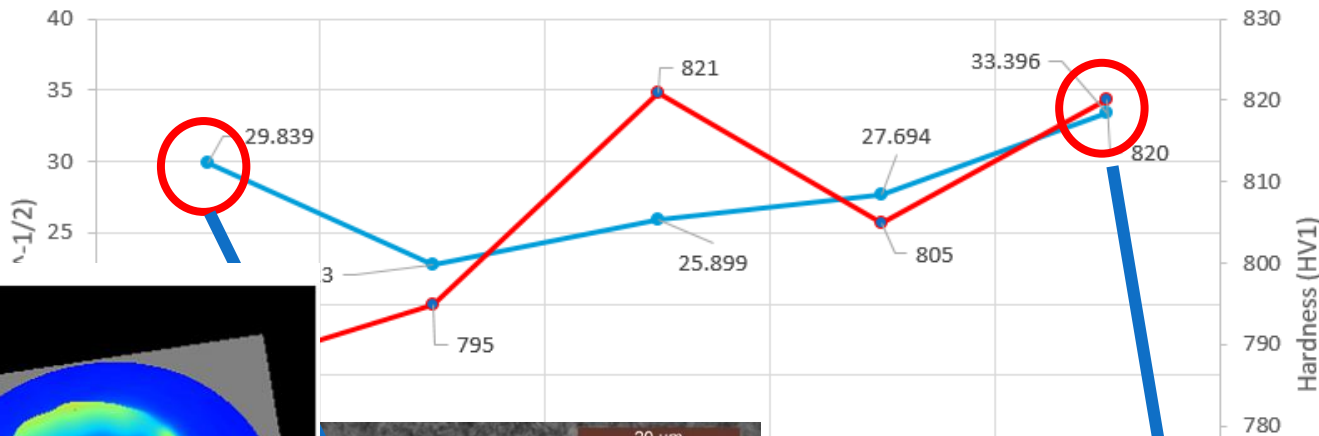


Crack !!!



DCT Parameters Effect on YXR3

K1c and Hardness of YXR3 Vs. Treatment conditions



Conclusions

- 1) DCT process **improves the wear resistance** of high-speed steel **up to 80%** compared to the conventional heat-treatment process.
- 2) DCT refining both carbide precipitation and martensite matrix in the microstructure resulting in **wear mechanism improvement** in both in Stage 1 and Stage 2.
- 3) The effect of DCT on tool materials need to be investigated separately
- 4) Scratch testing technique is a useful technique capturing the significant change in microscopic level (micro toughness) which **cannot** be investigated by conventional bulk testing technique i.e. Charpy impact test.
- 5) XRD is a useful technique to study the microstructure change, phase identification and residual stress analysis.



**THANK
YOU
FOR
YOUR
ATTENTION**